

32-bit RISC microcontroller

TXZ+ Family TMPM4N Group (1)

Reference Manual Clock Control and Operation Mode (CG-M4N(1)-C)

Revision 1.4

2025-07

Toshiba Electronic Devices & Storage Corporation



Contents

| Preface | 7 |
|--|----|
| Related Document | 7 |
| Conventions | 8 |
| Terms and Abbreviations | 10 |
| Clock Control and Operation Mode | 11 |
| 1,1, Outlines | |
| 1.2. Clock Control | |
| 1.2.1. Clock Type | |
| 1.2.2. Initial Value by Reset Operation | |
| 1.2.3. Clock System Diagram | |
| 1.2.4. Warming-up Function | |
| 1.2.4.1. Warming-up Timer for High-speed Oscillation | |
| 1.2.4.2. Warming-up Timer for Low-speed Oscillation | |
| 1.2.4.3. Directions for Warming-up Timer | 15 |
| 1.2.5. Clock Multiplying Circuit (PLL) for fsys | 16 |
| 1.2.5.1. PLL Setup after Reset Release | 16 |
| 1.2.5.2. Formula and Example of Setting of PLL Multiplication Value | 16 |
| 1.2.5.3. Change of PLL Multiplication Value under Operation | 18 |
| 1.2.5.4. PLL Operation Start/stop/switching Procedure | |
| 1.2.6. System Clock | 20 |
| 1.2.6.1. Setting Method of System Clock | |
| 1.2.7. Low-speed Clock | 24 |
| 1.2.8. Clock Supply Setting Function | |
| 1.2.9. Prescaler Clock | |
| 1.3. Operation Mode | 26 |
| 1.3.1. Details of Operation Mode | 26 |
| 1.3.1.1. Feature in Each Mode | |
| 1.3.1.2. Transition to and Return from Low-power Consumption Mode | |
| 1.3.1.3. Selection of Low-Power Consumption Mode | |
| 1.3.1.4. Peripheral Function State in Low-power Consumption Mode | |
| 1.3.2. Mode State Transition | |
| 1.3.2.1. IDLE Mode Transition Flow | |
| 1.3.2.2. STOP3 Mode Transition Flow | |
| 1.3.2.3. STOP2 Mode Transition Flow | |
| 1.3.3. Return Operation from Low-power Consumption Mode 1.3.3.1. Release Source of Low-power Consumption Mode | |
| 1.3.3.1. Release Source of Low-power Consumption Mode | |
| 1.3.3.3. Restart Operation from STOP2 Mode | |
| 1.3.4. Clock Operation by Mode Transition | |
| 1.3.4.1. NORMAL → IDLE → NORMAL Operation Mode Transition | |
| - September 1997 | |



| 1.3.4.2. NORMAL \rightarrow STOP1 \rightarrow NORMAL Operation Mode Transition | 37 |
|--|----|
| 1.3.4.3. NORMAL \rightarrow STOP2 \rightarrow RESET \rightarrow NORMAL Operation Mode Transition | 38 |
| 1.4. Registers | 39 |
| 1.4.1. List of Registers | 39 |
| 1.4.1.1. Clock Control and Operation Mode | 39 |
| 1.4.1.2. Low-speed Oscillation/power Control (Note1, Note2) | 39 |
| 1.4.2. Details of Register | 40 |
| 1.4.2.1. [CGPROTECT] (CG Write Protection Register) | 40 |
| 1.4.2.2. [CGOSCCR] (Oscillation Control Register) | 40 |
| 1.4.2.3. [CGSYSCR] (System Clock Control Register) | 41 |
| 1.4.2.4. [CGSTBYCR] (Standby Control Register) | 42 |
| 1.4.2.5. [CGPLL0SEL] (PLL Selection Register for fsys) | 42 |
| 1.4.2.6. [CGWUPHCR] (High-speed Oscillation Warming-up Register) | 43 |
| 1.4.2.7. [CGWUPLCR] (Low-speed Oscillation Warming-up Register) | 43 |
| 1.4.2.8. [CGFSYSMENC] (Middle-speed Clock Supply and Stop Register C for fsysm) | 44 |
| 1.4.2.9. [CGFSYSMENA] (Middle-speed Clock Supply and Stop Register A for fsysm) | 45 |
| 1.4.2.10. [CGFSYSMENB] (Middle-speed Clock Supply and Stop Register B for fsysm) | |
| 1.4.2.11. [CGFSYSENA] (High-speed Clock Supply and Stop Register A for fsysh) | |
| 1.4.2.12. [CGFCEN] (Clock Supply and Stop Register for fc) | |
| 1.4.2.13. [CGSPCLKEN] (Clock Supply for ADC and Debug Circuit Register) | |
| 1.4.2.14. [CGEXTEND2] (Function Extension Register 2) | |
| 1.4.2.15. [RLMLOSCCR] (Low-speed Oscillation and Internal High-speed Oscillation 2 Clock Control Register) | |
| 1.4.2.16. [RLMSHTDNOP] (Power Supply Cut Off Control Register) | |
| 1.4.2.17. [RLMPROTECT] (RLM Write Protection Register) | |
| 1.5. Information for Each Product | |
| 1.5.1. [CGFSYSENA] | |
| 1.5.2. [CGFSYSMENA] | |
| 1.5.3. [CGFSYSENB] | 55 |
| 1.5.4. [CGFSYSENC] | 56 |
| 1.5.5. [CGFCEN] | 57 |
| 2. Memory Map | 58 |
| 2.1. Outline | 58 |
| 2.1.1. TMPM4NxF20 | 59 |
| 2.1.2. TMPM4NxF15 | 60 |
| 2.1.3. TMPM4NxF10 | 61 |
| 2.1.4. TMPM4NxFD | 62 |
| 2.2. Bus Matrix | 63 |
| 2.2.1. Continuation | 64 |
| 2.2.1.1. Single Chip Mode | 64 |
| 2.2.1.2. Single Boot Mode | 65 |
| 2.2.2. Connection Table | |
| 2.2.2.1. Code Area/SRAM Area/SMIF Area/External Bus Area | |
| 2.2.2.2. Peripheral Area | 74 |
| 2.2.3. RAM Access | 75 |
| 2.2.3.1. List of Registers | 75 |
| | |



| | 2.2.3.2. Details of Register | 76 |
|----|--|----|
| 3. | Reset and Power Control | 77 |
| | 3.1. Outlines | 77 |
| | 3.2. Function and Operation | 78 |
| | 3.2.1. Cold Reset | 78 |
| | 3.2.1.1. Reset by Power-on Reset Circuit (without Using RESET_N pin) | 79 |
| | 3.2.1.2. Reset by RESET_N Pin | 80 |
| | 3.2.1.3. Continuation of Reset by LVD | 82 |
| | 3.2.2. Warm Reset | 83 |
| | 3.2.2.1. Warm Reset by REST_N Pin | 83 |
| | 3.2.2.2. Warm Reset by Internal Reset | 83 |
| | 3.2.3. Reset by STOP2 Mode Release | 84 |
| | 3.2.4. Starting Single Boot Mode | 85 |
| | 3.2.4.1. Starting Single Boot Mode by RESET_N Pin | 85 |
| | 3.2.4.2. Starting Single Boot Mode by Power-on Reset (Not Using RESET_N Pin) | 86 |
| | 3.2.4.3. Starting Single Boot Mode when Power Supply is Stable | 87 |
| | 3.2.5. Power-on Reset Circuit. | 88 |
| | 3.2.5.1. Operation at Time of Turn On | 88 |
| | 3.2.5.2. Operation at Time of Turn Off | 88 |
| | 3.2.6. Precautions when Turning Off Power | 89 |
| | 3.2.7. About Turn On Power Supply after Turn Off | 90 |
| | 3.2.7.1. When Using External Reset Circuit or Internal LVD Reset Output | 90 |
| | 3.2.7.2. When not Using External Reset Circuit and Internal LVD Reset Output | 90 |
| | 3.2.7.3. When Boundary Scan is Used | 90 |
| | 3.2.8. After Reset Release | 90 |
| | 3.2.8.1. Reset Factor and Reset Range | 91 |
| 4. | Revision History | 92 |
| RI | ESTRICTIONS ON PRODUCT USE | 94 |



List of Figures

| Figure 1.1 | Clock System Diagram | 13 |
|-------------|---|----|
| Figure 1.2 | Change State Transition | 30 |
| Figure 1.3 | STOP2 Mode Restart Operation Flow | 36 |
| Figure 1.4 | NORMAL → STOP1 → NORMAL Operation Mode Transition | 37 |
| Figure 1.5 | NORMAL → STOP2 → RESET → NORMAL Operation Mode Transition | 38 |
| Figure 2.1 | TMPM4NxF20 | 59 |
| Figure 2.2 | TMPM4NxF15 | 60 |
| Figure 2.3 | TMPM4NxF10 | 61 |
| Figure 2.4 | TMPM4NxF10 | 62 |
| Figure 2.5 | Single Chip Mode | |
| Figure 2.6 | Single Boot Mode | |
| Figure 3.1 | Reset Operation by Power-on Reset Circuit | 79 |
| Figure 3.2 | Reset Operation by RESET_N Pin (1) | 80 |
| Figure 3.3 | Reset Operation by RESET_N Pin (2) | 81 |
| Figure 3.4 | Reset Operation by LVD Reset | 82 |
| Figure 3.5 | Warm Reset Operation | 83 |
| Figure 3.6 | Starting Single Boot Mode by RESET_N Pin | 85 |
| Figure 3.7 | Starting Single Boot Mode by Power-on Reset (Not Using RESET_N Pin) | 86 |
| Figure 3.8 | Starting Single Boot Mode when Power Supply is Stable | 87 |
| Figure 3.9 | Power-on Reset Circuit | 88 |
| Figure 3.10 | Falling Gradient when Turning Off Power | 80 |



List of Tables

| Table 1.1 | Details of [CGPLL0SEL] <pll0set [23:0]="">Setup</pll0set> | 16 |
|------------|---|----|
| Table 1.2 | PLL Correction Value (example) | |
| Table 1.3 | PLL0SET Setting Value (example) | 17 |
| Table 1.4 | Clock Domains of CPU and Peripherals | 20 |
| Table 1.5 | Time Interval for Changing System Clock | 20 |
| Table 1.6 | Example of Operating Frequency | |
| Table 1.7 | Operating Frequency Examples of High-speed and Middle-speed System Clocks | 21 |
| Table 1.8 | Time Interval for Changing Prescaler Clock | 25 |
| Table 1.9 | Low-power Consumption Mode Selection | |
| Table 1.10 | Block Operation Status in Each Low-power Consumption Mode | |
| Table 1.11 | Release Source List | |
| Table 1.12 | Warming Up | |
| Table 1.13 | Allocation of [CGFSYSENA] by Each Product | |
| Table 1.14 | Allocation of [CGFSYSMENA] by Each Product | |
| Table 1.15 | Allocation of [CGFSYSMENB] by Each Product | |
| Table 1.16 | Allocation of [CGFSYSMENC] by Each Product | |
| Table 1.17 | Allocation of [CGFCEN] by Each Product | |
| Table 2.1 | TMPM4NxF20 Single Chip Mode | |
| Table 2.2 | TMPM4NxF20 Single Boot Mode | |
| Table 2.3 | TMPM4NxF15 Single Chip Mode | |
| Table 2.4 | TMPM4NxF15 Single Boot Mode | |
| Table 2.5 | TMPM4NxF10 Single Chip Mode | |
| Table 2.6 | TMPM4NxF10 Single Boot Mode | |
| Table 2.7 | TMPM4NxFD Single Chip Mode | |
| Table 2.8 | TMPM4NxFD Single Boot Mode | |
| Table 2.9 | Peripheral Area | |
| | Number of Clocks to Access Each RAM | |
| Table 3.1 | Reset Factor and Range Initialized | |
| Table 4.1 | Revision History | 92 |



Preface

Related Document

| Document name |
|--|
| Arm® Cortex®-M4 Processor Technical Reference Manual |
| Datasheet of Products (Electrical Characteristics) |
| Exception |
| Voltage Detection Circuit |
| Flash Memory |



Conventions

• Numeric formats follow the rules as shown below:

Hexadecimal: 0xABC

Decimal: 123 or 0d123 - Only when it needs to be explicitly shown that they are decimal

numbers.

Binary: 0b111 - It is possible to omit the "0b" when the number of bits can be

distinctly understood from a sentence.

" N" is added to the end of signal names to indicate low active signals.

• It is called "assert" that a signal moves to its active level, "deassert" to its inactive level.

• When two or more signal names are referred, they are described like as [m:n]. Example: S[3:0] shows four signal names S3, S2, S1 and S0 together.

• The characters surrounded by [] defines the register.

Example: [ABCD]

• "N" substitutes suffix number of two or more same kind of registers, fields, and bit names.

Example: [XYZ1], [XYZ2], $[XYZ3] \rightarrow [XYZn]$

• "x" substitutes suffix number or character of units and channels in the register list.

• In case of unit, "x" means A, B, and C, ...

Example: [ADACR0], [ADBCR0], $[ADCCR0] \rightarrow [ADxCR0]$

• In case of channel, "x" means 0, 1, and 2, ...

Example: [T32A0RUNA], [T32A1RUNA], $[T32A2RUNA] \rightarrow [T32AxRUNA]$

• The bit range of a register is written like as [m: n].

Example: Bit[3: 0] expresses the range of bit 3 to 0.

• The configuration value of a register is expressed by either the hexadecimal number or the binary number. Example: [ABCD]<EFG> = 0x01 (hexadecimal), [XYZn]<VW> = 1 (binary)

• Word and byte represent the following bit length.

Byte: 8 bits
Half word: 16 bits
Word: 32 bits
Double word: 64 bits

• Properties of each bit in a register are expressed as follows:

R: Read only W: Write only

R/W: Read and write are possible.

- Unless otherwise specified, register access supports only word access.
- The register defined as "Reserved" must not be rewritten. Moreover, do not use the read value.
- The value read from the bit having default value of "-" is unknown.
- When a register containing both of writable bits and read-only bits is written, read-only bits should be written with their default value, In the cases that default is "-", follow the definition of each register.
- Reserved bits of the write-only register should be written with their default value. In the cases that default is "-", follow the definition of each register.
- Do not use read-modified-write processing to the register of a definition which is different by writing and read out.



Arm and Cortex are registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere. All rights reserved.



All other company names, product names, and service names mentioned herein may be trademarks of their respective companies.



Terms and Abbreviations

Some of abbreviations used in this document are as follows:

ADC Analog to Digital Converter APB Advanced Peripheral Bus

A-PMD Advanced Programmable Motor Control Circuit

CAN Controller Area Network
CEC Consumer Electronics Control
CG Clock Control and Operation Mode

DAC Digital to Analog Converter

DNF Digital Noise Filter

ELOSC External Low-speed Oscillator EHOSC External High-speed Oscillator

EI2C I²C Interface Version A

ETHM Ether MAC

FIR Finite Impulse Response fsys Frequency of SYSTEM Clock

HDMAC High-speed Direct Memory Access Controller

I2C Inter-integrated Circuit

I2CS Wake-up Function by Address Matching

I2S Inter-IC Sound

IHOSC Internal High-speed Oscillator
IA (INTIF) Interrupt Control Register A
IB (INTIF) Interrupt Control Register B
I-Bus Icode Memory Interface
ISD Interval Sensing Detector

IMN Interrupt Monitor

INT Interrupt

IO IO Bus (32-bit Peripheral Bus)

LTTMR Long Term Timer

LVD Voltage Detection Circuit

MDMAC Multi-function Direct Memory Access Controller

NBDIF Non-break Debug Interface NMI Non-Maskable Interrupt OFD Oscillation Frequency Detector

POR Power-on Reset Circuit

PORF Power-on Reset Circuit for Flash and Debug
RLM Low-speed Oscillation/Power Supply Control/reset

RMC Remote Control Signal Preprocessor

RTC Real Time Clock
S-Bus System Interface
SCOUT Source Clock Output

SIWDT Clock Selective Watchdog Timer

SMIF Serial Memory Interface
TPIU Trace Port Interface Unit
TRGSEL Trigger Selection Circuit
TRM Trimming Circuit

TSPI Serial Peripheral Interface
TSSI Serial Synchronous Interface
T32A 32-Bit Timer Event Counter

UART Asynchronous Serial Communication Circuit

USB Universal Serial Bus



1. Clock Control and Operation Mode

1.1. Outlines

The clock/mode control block can select a clock gear and prescaler clock and set the warming-up of oscillator and so on. Furthermore, it has NORMAL mode and a low-power consumption mode to reduce power consumption using mode transition.

Functions related to a clock are as follows.

- System clock control
- Prescaler clock control

1.2. Clock Control

1.2.1. Clock Type

This section shows a list of clocks:

EHCLKIN: High-speed clock input from the external

fosc: Clock generated in the internal oscillation circuit or input from the X1 and X2 pins

f_{PLL}: Clock multiplied with PLL0

fc: Clock selected by [CGPLL0SEL]<PLL0SEL> (High-speed clock)

ELCLKIN: Low-speed clock input from the external

fs: Clock output from an external low-speed oscillator

fsysh: High-speed system clock selected by [CGSYSCR]<GEAR[2:0]>

fsysm: Middle-speed system clock selected by [CGSYSCR]<GEAR[2:0]><MCKSEL[1:0]>
ΦT0h: High-speed clock selected by [CGSYSCR]<PRCK[3:0]> (High-speed prescaler clock)

ΦT0m: Middle-speed clock selected by [CGSYSCR]<PRCK[3:0]><MCKSEL[1:0]>

(Middle-speed prescaler clock)

f_{IHOSC1}: Clock generated with the internal high-speed oscillator 1 f_{IHOSC2}: Clock generated with the internal high-speed oscillator 2

ADCLK: Conversion clock for AD converter

TRCLKIN: Clock for tracing facilities of a debugging circuit (TRACE or SWV)

Note: The high-speed system clock and the middle-speed system clock are collectively called System clock (fsys). And the high-speed prescaler clock and the middle-speed prescaler clock are collectively called prescaler clock (Φ T0).

11 / 94



1.2.2. Initial Value by Reset Operation

A clock setup is initialized to the following states by a reset action.

External high-speed oscillator: Stop

Internal high-speed oscillator 1: Oscillation
Internal high-speed oscillator 2: Stop (Note)

External low-speed oscillator: Stop PLL (multiplying circuit): Stop

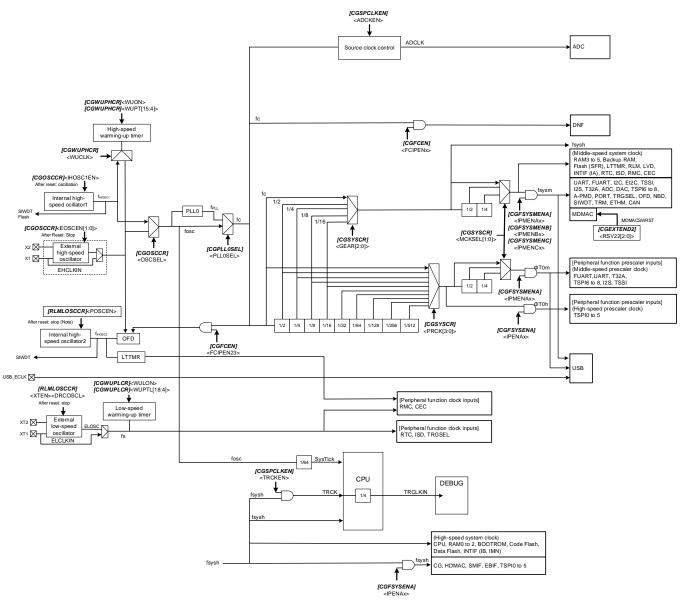
Gear clock: fc (no frequency dividing)

Note: The state after the initialization done by RESET_N pin depends on [RLMLOSCCR]<POSCEN> setting.



1.2.3. Clock System Diagram

The figure below shows a clock system diagram.



Note: The state after the initialization done by the reset from the pin depends on [RLMLOSCCR]<POSCEN> setting.

Figure 1.1 Clock System Diagram



1.2.4. Warming-up Function

A warming-up function is used to secure the oscillation stable time at the time of the STOP1 mode release which starts the warming-up timer for high-speed oscillation automatically.

It is available also as a count-up timer which uses the exclusive warming-up timer of high-speed clock /each low-speed clock for the waiting for the stability of an external oscillator or an internal oscillator.

This chapter explains the setting method to the register for warming-up timers, and the case where it is used as a count-up timer. The detailed explanation at the time of STOP1 mode release, refer to "1.3.3.2. Warming Up at Release of Low-power Consumption Mode".

1.2.4.1. Warming-up Timer for High-speed Oscillation

A 16-bit up-counter is built in as a warming-up timer only for a high-speed oscillation. Also, when setting before changes to the STOP1 mode, the setting value is calculated in the following formula, set [CGWUPHCR]<WUPT[15:4]> to the upper 12 bits of the setting value. Lower 4 bits are ignored.

<Formula>

(When using external high-speed oscillator)

```
Warming-up timer setting value (16 bits)
= warming-up time (s) / clock period (s) - 16
```

(Example) When 5ms of warming-up time is set up with 10 MHz (100 ns of clock periods) of oscillator

```
Warming-up timer setting value (16 bits) = 5 \text{ms} / 100 \text{ns} - 16
```

= 50000 - 16

=49984

= 0xC340

Since upper 12 bits are used, set the register as follows.

```
[CGWUPHCR]<WUPT[15:4]> = 0xC34
```

(When using internal high-speed oscillator 1)

```
Warming-up timer setting value (16 bits)
= (Warming-up time (s) -63.3μs) / clock period (s) - 41
```

(Example) When 163.4µs of warming time is set up with 10 MHz (100 ns of clock periods) of oscillator

```
Warming-up timer setting value (16 bits) = (163.4 \mu s - 63.3 \mu s) / 100 ns - 41
```

 $= 100.1 \mu s / 100 ns - 41$

= 960

= 0x03C0

Since upper 12 bits are used, set the register as follows.

```
[CGWUPHCR] < WUPT[15:4] > = 0x03C
```

In the case of 10MHz, the setting range is $0x03C \le <WUPT[15:4]> \le 0xFFF$, the warming-up time is set from 163.4µs to 6.6194ms.



1.2.4.2. Warming-up Timer for Low-speed Oscillation

A 19-bit up-timer is built in as a warming-up timer only for a low-speed oscillation. The setting value is calculated in the following formula, set *[CGWUPLCR]*<WUPT[18:4]> to the upper 15 bits of the setting value. Lower 4 bits are ignored. 16 is subtracted in order to perform the count for 4 bits of low ranks, even when a set point is "0".

<Formula>

```
Warming-up timer setting value (19 bits)
= warming-up time (s) / clock period (s) - 16
```

(Example) When 50 ms of warming time is set up with 32 kHz (clock period 31.25μs) of oscillator

Warming-up timer setting value (19 bits) $= 50 \text{ms} / 31.25 \mu \text{s} - 16$ = 1600 - 16= 1584

= 0x00630

Since upper 15 bits are used, set the register as follows.

[CGWUPLCR]<WUPTL[18:4]> = 0x0063

In the case of 32 kHz, it setting range is $0x0000 \le <WUPTL[18:4]> \le 0x7FFF$, warming-up time is set from 500µs to 16.384s.

1.2.4.3. Directions for Warming-up Timer

The directions for a warming-up function are explained.

- (1) Selection of a clock
 In a high-speed oscillation, the clock classification (an internal oscillation/external oscillation) counted with a warming-up timer is selected by *[CGWUPHCR]*<WUCLK>.
- (2) Calculation of a warming-up timer setting value

 The warming-up time can set any value to the timer for a high-speed oscillation/for a low-speed oscillation.

 Please compute and set up from each formula.
- (3) Start of warming up, and a termination confirmation When software (instruction) performs the start of warming-up, starting warming-up count is carried out by setting *[CGWUPHCR]*<WUON> (or *[CGWUPLCR]*<WULON>) to "1".

Termination is confirmed with *[CGWUPHCR]*<WUEF> (or *[CGWUPLCR]*<WULEF>) that becomes from "1" to "0". "1" indicates under warming up and "0" indicates termination. After a counting end, the timer is reset and returns to an initial state.

It is not forced to terminate, although "0" is written to *[CGWUPHCR]*<WUON> (or *[CGWUPLCR]*<WULON>) during timer operation. Writing "0" is ignored.

Note: Since it is operating with the oscillating clock, a warming-up timer includes an error, when oscillation frequency has fluctuation. Therefore, it should be taken as an approximate time.



1.2.5. Clock Multiplying Circuit (PLL) for fsys

The clock multiplying circuit outputs the f_{PLL} clock (up to 200MHz) multiplied by the optimum condition for the frequency (8 MHz to 24 MHz) of the output clock f_{OSC} of the high-speed oscillator.

So, it is possible to make the input frequency to an oscillator low-speed and to make an internal clock high-speed by this circuit.

1.2.5.1. PLL Setup after Reset Release

The PLL is disabled after reset release.

To use the PLL, set [CGPLL0SEL]<PLL0SET[23:0]> to a multiplication value while [CGPLL0SEL]<PLL0ON> is "0". Then wait until approximately 100 μ s has elapsed as a PLL initial stabilization time, and set <PLL0ON> to "1" to start PLL operation.

After that, to use f_{PLL} clock which is multiplied fosc, wait until approximately 400 μ s has elapsed as a lock-up time. Then set "1" to *[CGPLL0SEL]*<PLL0SEL>.

Note that a warming-up time is required until PLL operation becomes stable using the warming-up function, etc.

1.2.5.2. Formula and Example of Setting of PLL Multiplication Value

The details of the items of *[CGPLL0SEL]*<PLL0SET[23:0]> which set up a PLL multiplication value are shown below.

Table 1.1 Details of [CGPLL0SEL]<PLL0SET [23:0]>Setup

| Items of PLL0SET | Function | | |
|------------------|---|---|--|
| [23:17] | Correction value setting | I the quotient of tocc / (b) k (integer) For detail refer to Table 1.7 | |
| [16:14] | $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | | 101: 15 < fosc ≤ 19 110: 19 < fosc ≤ 24 |
| [13:12] | Dividing setup | 00: Reserved 01: Divided by 2 (x 1 / 2) 10: Divided by 4 (x 1 / 4) 11: Divided by 8 (x 1 / 8) | |
| [11:8] | Fractional part of multiplication setup | 0000: 0.0000 1000: 0.5000 0001: 0.0625 1001: 0.5625 0010: 0.1250 1010: 0.6250 0011: 0.1875 1011: 0.6875 | |
| [7:0] | 0x00: 0 0x01: 1 0x02: 2 : 0xFD: 253 0xFE: 254 0xFF: 255 | | |

Note: A multiplication value is the total of <PLL0SET[7:0]> (integer part) and <PLL0SET[11:8]> (fractional part).



f_{PLL} is denoted by the following formulas.

 $f_{PLL} = fosc \times (\textit{[CGPLL0SEL]} < PLL0SET[7:0] > + \textit{[CGPLL0SEL]} < PLL0SET[11:8] >) \times \\ (\textit{[CGPLL0SEL]} < PLL0SET[13:12] >)$

Note1: Frequency accuracy is not guaranteed.

Note2: There is no Linearity in the frequency by the fractional part of multiplication setup.

Note3: f_{PLL} ≤ Maximum Operating Frequency

Table 1.2 PLL Correction Value (example)

| fosc (MHz) | <pll0set[23:17]> (decimal, integral value)</pll0set[23:17]> |
|------------|---|
| 8.00 | 18 |
| 10.00 | 23 |
| 12.00 | 27 |
| 16.00 | 36 |
| 20.00 | 45 |
| 24.00 | 54 |

A PLL correction value can be calculated below.

When fosc = 10.0 MHz, $10.0 / 0.45 = 22.22 \approx 23$; fractional part is rounded up.

The main examples of a setting of [CGPLL0SEL]<PLL0SET[23:0]> are shown below.

- (1) It multiplies by PLL, and dividing is carried out and the target clock frequency (f_{PLL}) is generated for input frequency (fosc).
- (2) A dividing value is chosen from 1/2, 1/4, and 1/8.

Moreover, set up the frequency after multiplication in the following ranges.

200 MHz \leq (fosc \times multiplication value) \leq 400 MHz

Table 1.3 PLL0SET Setting Value (example)

| fosc (MHz) | Multiplication value | Dividing value | f _{PLL} (MHz) | <pll0set[23:0]></pll0set[23:0]> |
|------------|----------------------|----------------|------------------------|---------------------------------|
| 8.00 | 50.0000 | 1/2 | 200 | 0x245032 |
| 10.00 | 40.0000 | 1/2 | 200 | 0x2E9028 |
| 12.00 | 33.3150 | 1/2 | 199.89 | 0x36D521 |
| 16.00 | 25.0000 | 1/2 | 200 | 0x495019 |
| 16.00 | 12.5000 | 1/2 | 100 | 0x49580C |
| 20.00 | 20.0000 | 1/2 | 200 | 0x5B9014 |
| 24.00 | 16.6575 | 1/2 | 199.89 | 0x6D9A10 |
| 12.00 | 32.000 | 1/4 | 96 | 0x36E020 |
| 12.00 | 32.000 | 1/2 | 192 | 0x36D020 |
| 16.00 | 24.000 | 1/4 | 96 | 0x496018 |
| 16.00 | 24.000 | 1/2 | 192 | 0x495018 |
| 24.00 | 16.000 | 1/2 | 192 | 0x6D9010 |



1.2.5.3. Change of PLL Multiplication Value under Operation

It changes to a setup which sets "0" to [CGPLL0SEL]<PLL0SEL> first, and does not use a PLL multiplication clock during PLL multiplication clock operation when changing a multiplication value. And [CGPLL0SEL]
<PLL0ST> = 0 is read, after checking having changed to a setup which does not use a multiplication clock, [CGPLL0SEL]
FLL0ON> is set to "0", and PLL is stopped.

Then, the multiplication value of *[CGPLL0SEL]*<PLL0SET> is changed, as reset time of PLL, after about 100µs progress, *[CGPLL0SEL]*<PLL0ON> is set to "1", and operation of PLL is started.

Then, [CGPLL0SEL]<PLL0SEL> is set to "1" after locking-up time (about 400µs) has elapsed.

Finally, [CGPLL0SEL]<PLL0ST> is read and it checks having changed.



1.2.5.4. PLL Operation Start/stop/switching Procedure

(1) fc setup (PLL stop → PLL start) As an fc setup, the example of switching procedure from the PLL stop state to the PLL operation state is as follows.

| < <state before="" switching="">></state> | | |
|--|---|--|
| [CGPLL0SEL] <pll0on> = 0 Stop the PLL operation for fsys.</pll0on> | | |
| [CGPLL0SEL] <pll0sel> = 0</pll0sel> | Select the setting of the PLL for fsys to "PLL is unused (fosc)". | |
| [CGPLL0SEL] <pll0st> = 0</pll0st> | Indicate the status of the PLL for fsys to "PLL is unused (fosc)". | |
| [CGSYSCR] <mcksel> = 00</mcksel> | Ratios of "high-speed system clock vs middle-speed system clock" and "high-speed prescaler clock vs middle-speed system clock" are 1:1. | |

| | < <example of="" procedure="" switching="">></example> | | |
|---|---|---|--|
| 1 | [CGSYSCR] <mcksel[1:0]> = 01 or 1*</mcksel[1:0]> | Ratios of (High-speed system clock vs middle-speed system clock) and (High-speed prescaler clock vs High-speed system clock) are changed. | |
| 2 | [CGSYSCR] <mckselgst> and <mckselpst> are read.</mckselpst></mckselgst> | Wait until they become the values set at Step 1. | |
| 3 | [CGPLL0SEL] <pll0set[23:0]> = 0xX</pll0set[23:0]> | A PLL multiplication value setup is chosen. | |
| 4 | Wait 100 μs or more. | Latency time after a multiplication setup | |
| 5 | [CGPLL0SEL] <pll0on> = 1</pll0on> | PLL operation for fsys is carried out to an oscillation. | |
| 6 | Wait 400 μs or more. | PLL output clock stable latency time | |
| 7 | [CGPLL0SEL] <pll0sel> = 1</pll0sel> | PLL selection for fsys is carried out to PLL use (f _{PLL}). | |
| 8 | [CGPLL0SEL] <pll0st> is read</pll0st> | It waits until the PLL selection status for fsys becomes PLL use (f _{PLL}) (= 1). | |

Note1: Step 1 and 2 are executed when the ratio of the system clock should be changed.

Note2: Step 3 to 6 are unnecessary when the state before switching is *[CGPLL0SEL]*<PLL0ON> = 1. When changing from the state where the PLL output clock is stable, it can be changed to the PLL operation state by execution of only step 7 and 8.

(2) fc setup (PLL operation → PLL stop)
As an fc setup, the example of switching procedure from the PLL operation state to a PLL stop state is as follows.

| < <state before="" switching="">></state> | | |
|--|---|--|
| [CGPLL0SEL] <pll0on> = 1</pll0on> | Sets the PLL for fsys to oscillate. | |
| [CGPLL0SEL] <pll0sel> = 1</pll0sel> | Selects the PLL for fsys to "PLL is used (f _{PLL})". | |
| [CGPLL0SEL] <pll0st> = 1</pll0st> | Indicates the status of the PLL for fsys to "PLL is used (fPLL)". | |

| | < <example of="" sequence="" switching="">></example> | | | | | |
|---|--|--|--|--|--|--|
| 1 | [CGPLL0SEL] <pll0sel> = 0</pll0sel> | Select the PLL for fsys to "PLL is unused (fosc)". | | | | |
| 2 | [CGPLL0SEL] <pll0st> is read</pll0st> | Wait until the status of the PLL for fsys becomes "PLL is unused (fosc) (=0)". | | | | |
| 3 | [CGPLL0SEL] <pll0on> =0</pll0on> | Set the PLL operation for fsys to stop. | | | | |



1.2.6. System Clock

An internal high-speed oscillation clock or external high-speed oscillation clock (connected oscillator or clock input) can be used as a source of system clock.

The system clock consists of "high-speed system clock (fsysh) (up to 200MHz)" for high-speed operation and "middle-speed system clock (fsysm) (up to 100MHz)" which is generated by dividing high-speed system clock. Middle-speed system clock is used by peripheral function to save power dissipation without degrading CPU performance. The clock domains of the peripheral function can be checked in Table 1.4.

High-speed system clock is generated by dividing fc using *[CGSYSCR]*<GEAR [2:0]> (clock gear). And middle-speed system clock is generated by dividing the high-speed system clock using *[CGSYSCR]*<MCKSEL[1:0]>. Although a setting can be changed during operation, after register writing before the clock actually changes, a time interval shown in Table 1.5 is required. The completion of the clock change should be checked by *[CGSYSCR]*<GEARST [2:0]> and <MCKSELGST[1:0]>.

Table 1.4 Clock Domains of CPU and Peripherals

| Clock domain | Functions |
|---------------------------|--|
| High-speed system clock | CPU, Code Flash, Data Flash, HDMAC, EBIF, SMIF, TSPI (ch0 to 5), CG, INTIF, RAM0 to 2, Boot ROM |
| Middle-speed system clock | MDMAC, NBDIF, I2C, SIWDT, UART, FUART, DAC, TSPI (ch6 to 8), T32A, ADC, Port, PMD, DNF, LTTMR, LVD, RLM, ISD, TRM, CAN, USB, Flash (SFR), OFD, EI2C, I2S, FIR, TSSI, TRGSEL, RAM3 to 5, Backup RAM, ETHM |

Table 1.5 Time Interval for Changing System Clock

| System clock | High-speed (fsysh) | Middle-speed (fsysm) |
|--------------|-----------------------|-----------------------|
| fsys | up to 16 clocks of fc | up to 16 clocks of fc |
| fsys / 2 | - | up to 32 clocks of fc |
| fsys / 4 | - | up to 64 clocks of fc |

Note1: The clock gear and the system clock should not be changed while the peripheral function such as the timer/counter is operating.

Note2: An access between high-speed system clock domain and Middle-speed system clock domain cannot be done when the system clock is changing.



Table 1.6 shows the example of operating frequency by the clock gear ratio (1/1 to 1/16) to the frequency fc set up with oscillation frequency, a PLL multiplication value, etc.

Table 1.6 Example of Operating Frequency

| External oscillation | External clock input (MHz) | Internal oscillation IHOSC1 | PLL multiplication value | ation frequency (fc) | | _ | requen ratio (l LL = O | MHz) | clock | Oper | _ | requen ratio (I LL = Ol | MHz) | clock |
|----------------------|----------------------------|-----------------------------------|--------------------------------|----------------------|-----|-----|------------------------------|------|-------|------|-----|-------------------------------|------|-------|
| (MHz) | | (MHz) (afte | (after dividing) | (MHz) | 1/1 | 1/2 | 1/4 | 1/8 | 1/16 | 1/1 | 1/2 | 1/4 | 1/8 | 1/16 |
| 8 | 8 | = | 25 | 200 | 200 | 100 | 50 | 25 | 12.5 | 8 | 4 | 2 | 1 | - |
| 10 | 10 | 10 | 20 | 200 | 200 | 100 | 50 | 25 | 12.5 | 10 | 5 | 2.5 | 1.25 | - |
| 12 | 12 | - | 16 | 192 | 192 | 96 | 48 | 24 | 12 | 12 | 6 | 3 | 1.5 | - |
| 16 | 16 | - | 12 | 192 | 192 | 96 | 48 | 24 | 12 | 16 | 8 | 4 | 2 | 1 |
| 20 | 20 | = | 10 | 200 | 200 | 100 | 50 | 25 | 12.5 | 20 | 10 | 5 | 2.5 | 1.25 |

Table 1.7 Operating Frequency Examples of High-speed and Middle-speed System Clocks

| | | • | | | | |
|-------------------------------|-----|---|-----|--|--|--|
| High-speed system clock fsysh | | Middle-speed system clock fsysm (MHz) | | | | |
| (MHz) | 1/1 | 1/2 | 1/4 | | | |
| 200 | - | 100 | 50 | | | |
| 192 | - | 96 | 48 | | | |
| 160 | - | 80 | 40 | | | |
| 100 | 100 | 50 | 25 | | | |
| 96 | 96 | 48 | 24 | | | |
| 80 | 80 | 40 | 20 | | | |

Note: The maximum frequency of middle-speed system clock is 100 MHz.



1.2.6.1. Setting Method of System Clock

(1) fosc setup (internal oscillation \rightarrow external oscillation)

As a fosc setup, the example of switching procedure to the external high-speed oscillator (EHOSC) from an internal high-speed oscillator 1 (IHOSC1) is shown below.

| < <state before="" switching="">></state> | | |
|--|---|--|
| [CGOSCCR] <ihosc1en> = 1</ihosc1en> | An internal high-speed oscillator 1 oscillates. | |
| [CGOSCCR] <oscsel> = 0</oscsel> | The high-speed oscillation selection for fosc is an internal high-speed oscillator 1 (IHOSC1). | |
| [CGOSCCR] <oscf> = 0</oscf> | The high-speed oscillation selection status for fosc is an internal high-speed oscillator 1 (IHOSC1). | |
| An oscillator is connected to X1 and X2 pins. (Note) | - | |

Note: Do not connect any devices except a resonator.

| | < <example of="" procedure="" switching="">></example> | | | | | |
|---|---|---|--|--|--|--|
| 1 | [PYPDN] <bit[1:0]> = 00 [PYPUP]<bit[1:0]> = 00 [PYIE]<bit[1:0]> = 00</bit[1:0]></bit[1:0]></bit[1:0]> | Disable the pull-down resistors of X1 and X2 pins. Disable the pull-up resistors of X1 and X2 pins. Disable input control of X1 and X2 pins. | | | | |
| 2 | [CGOSCCR] <eoscen[1:0]> = 01</eoscen[1:0]> | It is an external oscillation (EHOSC) about selection of an external oscillation of operation. | | | | |
| 3 | [CGWUPHCR] <wuclk> = 1 [CGWUPHCR]<wupt[15:4]> = arbitrary value</wupt[15:4]></wuclk> | It is the external oscillation (EHOSC) about high-speed oscillation warming-up clock selection. Oscillator stable time is set to a warming-up timer setting value. | | | | |
| 4 | [CGWUPHCR] <wuon> = 1</wuon> | High-speed oscillation warming up is started. | | | | |
| 5 | [CGWUPHCR] <wuef> is read.</wuef> | It waits until it becomes the termination of high-speed oscillation warming up (= 0). | | | | |
| 6 | [CGOSCCR] <oscsel> = 1</oscsel> | It is high-speed oscillation selection for fosc to the external high-speed oscillator (EHOSC). | | | | |
| 7 | [CGOSCCR] <oscf> is read.</oscf> | It waits until the high-speed oscillation selection status for fosc becomes external high-speed oscillator (EHOSC) (= 1). | | | | |
| 8 | [CGOSCCR] <ihosc1en> = 0</ihosc1en> | An internal high-speed oscillator 1 is stopped. | | | | |

(2) fosc setup (internal oscillation → external clock input)
As a fosc setup, the example of switching procedure to the external clock input (EHCLKIN) from an internal oscillator 1 (IHOSC1) is shown below.

| < <state before="" switching="">></state> | | |
|--|--|--|
| [CGOSCCR] <ihosc1en> = 1</ihosc1en> | An internal high-speed oscillator1 oscillates. | |
| [CGOSCCR] <oscsel> = 0</oscsel> | The high-speed oscillation selection for fosc is an internal high-speed oscillator 1 (IHOSC1). | |
| [CGOSCCR] <oscf> = 0</oscf> | The high-speed oscillation selection status for fosc is an inside (IHOSC1). | |
| Clock input to EHCLKIN | Input in the proper voltage range. | |

| | < <example of="" procedure="" switching="">></example> | | | | |
|---|--|--|--|--|--|
| 1 | [PYPDN] <bit[0]> = 0 [PYPUP]<bit[0]> = 0 [PYIE]<bit[0]> = 0/1</bit[0]></bit[0]></bit[0]> | Disable the pull-down resistor of X1/EHCLKIN pin. Disable the pull-up resistors of X1/EHCLKIN pin. Input control of X1/EHCLKIN pin can be arbitrarily set. | | | |
| 2 | [CGOSCCR] <eoscen[1:0]> = 10</eoscen[1:0]> | Selection of an external oscillation of operation is carried out to an external high-speed clock input (EHCLKIN). | | | |
| 3 | [CGOSCCR] <oscsel> = 1</oscsel> | It is high-speed oscillation selection for fosc to the external high-speed oscillation. | | | |
| 4 | [CGOSCCR] <oscf> is read.</oscf> | It waits until the high-speed oscillation selection status for fosc becomes external high-speed oscillation (= 1). | | | |
| 5 | [CGOSCCR] <ihosc1en> = 0</ihosc1en> | An internal high-speed oscillator 1 is stopped. | | | |



(3) fosc setup (external oscillation/external clock input → internal oscillation)
As a fosc setup, the example of switching procedure to the internal high-speed oscillator 1 (IHOSC1) from an external high-speed oscillator (EHOSC) or an external clock input (EHCLKIN) is shown below.

| < <state before="" switching="">></state> | | | | |
|--|---|--|--|--|
| [CGOSCCR] <eoscen[1:0]> = 01 or 10</eoscen[1:0]> | Selection of an external oscillator of operation is an external high-speed oscillator (EHOSC) or external high-speed clock input. | | | |
| [CGOSCCR] <oscsel> = 1</oscsel> | The high-speed oscillation selection for fosc is the external high-speed oscillation (EHOSC). | | | |
| [CGOSCCR] <oscf> = 1</oscf> | The high-speed oscillation selection status for fosc is the external high-speed oscillation (EHOSC). | | | |

| | < <example of="" procedure="" switching="">></example> | | | | | |
|---|---|---|--|--|--|--|
| 1 | [CGWUPHCR] <wuclk> = 0</wuclk> | Set the warming-up clock selection to internal high-speed oscillator 1 (IHOSC1). | | | | |
| 2 | [CGWUPHCR] <wupt[15:4]> = 0x03C</wupt[15:4]> | Set the high-speed oscillation warming-up timer setting value of 163.4 μ s (= 0x3C) or more. | | | | |
| 3 | [CGOSCCR] <ihosc1en> = 1</ihosc1en> | An internal high-speed oscillator 1 oscillates. | | | | |
| 4 | [CGWUPHCR] <wuon> = 1</wuon> | Start the high-speed oscillation warming-up timer. | | | | |
| 5 | [CGWUPHCR] <wuef> is read.</wuef> | Wait until a warming-up timer status flag becomes ends (= 0). | | | | |
| 6 | [CGOSCCR] <oscsel> = 0</oscsel> | Set the high-speed oscillation selection for fosc to internal high-speed oscillator1 (IHOSC1). | | | | |
| 7 | [CGOSCCR] <oscf> is read.</oscf> | It waits until the internal high-speed oscillation selection status for fosc becomes an internal high-speed oscillation 1 (IHOSC1) (= 0). | | | | |
| 8 | [CGOSCCR] <eoscen[1:0]> = 00</eoscen[1:0]> | Set the selection of an external oscillator operation to unused. | | | | |



1.2.7. Low-speed Clock

(1) ELOSC setup (not used low-speed clock → external low-speed oscillator used)
An example of setting procedure is shown as follows to use the external low-speed oscillator (ELOSC).

| < <state before="" switching="">></state> | | | |
|--|--|--|--|
| [RLMLOSCCR] <xten> = 0</xten> | A low-speed clock is not used. | | |
| [RLMLOSCCR] <drcoscl> = 0</drcoscl> | The external low-speed clock input (ELCLKIN) is selected as the low-speed clock. | | |

| | < <example of="" procedure="" switching="">></example> | | | | |
|--|--|---|--|--|--|
| 1 | [PYPDN] bit[3:2]> = 00 [PYPUP] bit[3:2]> = 00 | The pull-down resistors on XT1/XT2 pins are disabled. The pull-up resistors on XT1/XT2 pins are disabled. | | | |
| | [PYIE] bit[3:2]> = 00 | Disable input control of XT1/XT2 pins. | | | |
| 2 [RLMLOSCCR] <drcoscl> = 1 The low-speed clock source is set to the external low-speed oscillate (ELOSC).</drcoscl> | | The low-speed clock source is set to the external low-speed oscillator (ELOSC). | | | |
| 3 | [RLMLOSCCR] <xten> = 1</xten> | The low-speed clock is used. | | | |
| 4 | 4 [RLMLOSCCR] <xten> is read. It waits until using a low-speed clock status becomes "used (= 1)".</xten> | | | | |
| 5 | 5 [CGWUPLCR] <wuptl> = arbitrary value Set the low-speed oscillation warming-up timer setting value.</wuptl> | | | | |
| 6 | [CGWUPLCR] <wulon> = 1</wulon> | Start the low-speed oscillation warming-up timer. | | | |
| 7 | [CGWUPLCR] <wulef> is read.</wulef> | It waits until it becomes the termination of low-speed oscillation warming up (= 0). | | | |

(2) ELCLKIN setup (no operation of external low-speed oscillator → operation)
An example of setting procedure is shown as follows to use the external low-speed clock input (ELCLKIN).

| < <state before="" switching="">></state> | | |
|--|--|--|
| [RLMLOSCCR] <xten> = 0 A low-speed clock is not used.</xten> | | |
| [RLMLOSCCR] <drcoscl> = 0</drcoscl> | The external low-speed clock input (ELCLKIN) is selected as the low-speed clock. | |

| | < <example of="" procedure="" switching="">></example> | | | | |
|---|---|--|--|--|--|
| 1 [PYPUP] bit[2]> = 0 Disable the pull-up resistor on XT1/ELCLKIN pin. | | Disable the pull-down resistor on XT1/ELCLKIN pin. Disable the pull-up resistor on XT1/ELCLKIN pin. Enable input control of XT1/ELCLKIN pin. | | | |
| 2 | 2 [RLMLOSCCR] <drcoscl> = 0 The external low-speed clock source is set to the external low-speed clock input (ELCLKIN).</drcoscl> | | | | |
| 3 | 3 [RLMLOSCCR] <xten> = 1 The low-speed clock is used.</xten> | | | | |
| 4 | [RLMLOSCCR] <xten> is read.</xten> | It waits until using a low-speed clock status becomes "used (= 1)". | | | |



1.2.8. Clock Supply Setting Function

TMPM4N Group (1) has the clock on/off function for the peripheral circuits. To reduce the power consumption, TMPM4N Group (1) can stop supplying the clock to the peripheral functions that are not used.

Except some peripheral functions, clocks are not supplied after reset.

To supply the clock of the function to be used, set the bit of relevance of [CGFSYSENA], [CGFSYSMENA], [CGFSYSMENC], [CGSPCLKEN] and [RLMLOSCCR] to "1".

For details, refer to "1.4. Registers".

1.2.9. Prescaler Clock

Each peripheral function has a prescaler circuit to divide the Φ T0 clock. Φ T0h or Φ T0m of prescaler clock is input to them. For which clock is input for each peripheral function, refer to "Figure 1.1 Clock System Diagram".

The clock which the divider divides fc by [CGSYSCR]<PRCK[3:0]> is Φ T0h.

The clock which the divider divides Φ T0h by [CGSYSCR]<MCKSEL[1:0]> is Φ T0m.

For Φ T0 clock after reset, fc is chosen.

After each register writing before a clock actually changes, a time interval shown in Table 1.8 is required.

To confirm the completion of the clock change, check the status of *[CGSYSCR]*<PRCKST[3:0]> or <MCKSELPST[1:0]>.

Table 1.8 Time Interval for Changing Prescaler Clock

| Prescaler clock | High-speed (ΦT0h) | Middle-speed (ΦT0m) | |
|-----------------|---------------------|----------------------|--|
| ФТ0 | Up to 512 fc cycles | Up to 512 fc cycles | |
| ФТ0 / 2 | - | Up to 1024 fc cycles | |
| ФТ0 / 4 | - | Up to 2048 fc cycles | |

Note1: Do not change a prescaler clock during operation of peripheral functions, such as a timer counter.

Note2: An access between high-speed system clock domain and Middle-speed system clock domain cannot be done when the prescaler clock is changing.



1.3. Operation Mode

There are NORMAL mode and a low-power consumption mode (IDLE, STOP1, and STOP2 mode) in TMPM4N Group (1) as an operation mode, and it can reduce power consumption by performing mode transition according to directions for use.

1.3.1. Details of Operation Mode

1.3.1.1. Feature in Each Mode

The feature in NORMAL, low-power consumption modes is as follows.

NORMAL mode

It is a mode to operate a CPU core and peripheral circuits by a high-speed oscillation clock. After the reset release, operation mode is NORMAL mode.

Low-power consumption mode

Low-power consumption modes are as following.

IDLE mode

It is the mode which CPU stops.

The peripheral function should perform operation/stop by the register of each peripheral function, a clock supply setting function, etc.

Note: CPU cannot clear the watchdog timer in IDLE mode.

STOP1 mode

It is the mode which all the internal circuits also including an internal oscillator stop.

However, when an external low-speed oscillator is oscillating and it shifts to STOP1 mode, the RTC, CEC, RMC and ISD operate.

If it shifts to STOP1 mode when the internal high-speed oscillator 2 (IHOSC2) is oscillating and LTTMR is selected as a sample clock, the CEC and RMC operate.

If the STOP1 mode is released, an internal high-speed oscillator1 (IHOSC1) will start, and operation mode will return to NORMAL mode.

Please disable interrupt which is not used for STOP1 release before shifting to the STOP1 mode.

STOP2 mode

It is the mode which holds a part of functions and cut off internal electrical power source. STOP1 consumption of electric power larger than the STOP2 mode can be held down. If the STOP2 mode is released, power supply will be switched on to the main power domain, a reset sequence will be performed, and it will return to NORMAL mode.

As for the main power domain, it is a function which does not supply a power supply in STOP2 mode.

Before shifting to the STOP2 mode, disable an interrupt which is not made into a release STOP2, please be sure to set up [RLMSHTDNOP]<PTKEEP> = 1 and to hold the state of each port.

An output/pull-up holds, and input permission hold a state when it sets as a port keeping function. In addition, external interrupt continues an input.



This product will be cut off the power except for the following circuit in STOP2 mode.

- External low-speed oscillator (ELOSC)
- RTC
- Backup RAM
- Port pin status
- LVD
- RMC
- ISD
- CEC
- LTTMR
- RLM
- IA
- Internal high-speed oscillator 2 (IHOSC2)

Regarding a power supply cut off in the low-power consumption mode, for details, refer to "1.3.1.4 Peripheral Function State in Low-power Consumption Mode".

1.3.1.2. Transition to and Return from Low-power Consumption Mode

To shift to each low-power consumption mode, the IDLE/STOP1/STOP2 mode is chosen by standby control register [CGSTBYCR]<STBY[1:0]>, and a WFI instruction is executed. When the transition to the low-power consumption mode has been done by WFI instruction, the return from a low-power consumption mode is performed by reset or interrupt generating. To return by an interrupt, it is necessary to set up. Please refer to "Interrupt" chapter of the reference manual "Exception" for details.

Note1: TMPM4N Group (1) does not support a return by events; therefore, do not make a transition to low-power consumption mode triggered by WFE (Wait For Event).

Note2: TMPM4N Group (1) does not support low-power consumption mode by SLEEPDEEP of the Cortex-M4 processor with FPU core. Do not use the <SLEEPDEEP> bit of the system control register.

1.3.1.3. Selection of Low-Power Consumption Mode

Low-power consumption mode selection is chosen by setup of *[CGSTBYCR]*<STBY[1:0]>. Following table shows the mode chosen from a setup of <STBY[1:0]>.

Table 1.9 Low-power Consumption Mode Selection

| Mode | [CGSTBYCR] <stby[1:0]></stby[1:0]> |
|-------|------------------------------------|
| IDLE | 00 |
| STOP1 | 01 |
| STOP2 | 10 |

Note: Do not use the settings other than the above.



1.3.1.4. Peripheral Function State in Low-power Consumption Mode

The following Table 1.10 shows the operation state of the peripheral function (block) in each low-power consumption mode.

In addition, after reset release, it will be in the state where a clock is not supplied except for some blocks. If needed, set up [CGFSYSENA], [CGFSYSMENA], [CGFSYSMENB], [CGFSYSMENC], [CGFCEN], [CGSPCLKEN] and enable clock supply.

Table 1.10 Block Operation Status in Each Low-power Consumption Mode

| Block | | | | STOP1 | | STOP2 (Note1) | |
|---|--------------|--------------------|-------------------------------|-----------|-----------|----------------|-----------|
| | | NORMAL | IDLE | ELOSC | ELOSC | ELOSC | ELOSC |
| | | | | On | Off | On | Off |
| Processor core (debug included) | | ✓ | - | - | - | х | х |
| HDMAC | | ✓ | √ | - | - | х | Х |
| MDMAC | | ✓ | ✓ | - | - | Х | Х |
| | Pin status | ✓ | ✓ | ✓ | ✓ | ✓ (Note3) | ✓ (Note3) |
| I/O port | Register | ✓ | ✓ | - | - | Х | Х |
| EBIF, ADC, DAC, UART, F EI2C, TSPI, SMIF, I2S, FII T32A, TRGSEL,CAN | | ✓ | √ | - | - | х | х |
| LTTMR | | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) |
| RTC | | ✓ | ✓ | ✓ | - | ✓ | - |
| RMC | | ✓ | ✓ | ✓ | - | ✓ | ✓ (Note4) |
| CEC | | ✓ | ✓ | ✓ | - | ✓ | ✓ (Note4) |
| ISD | | ✓ | ✓ | ✓ | - | ✓ | - |
| SIWDT | | ✓ | ✓ (Note2) | ✓ (Note2) | ✓ (Note2) | Х | Х |
| LVD | | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ |
| OFD | | ✓ | ✓ | - | - | Х | Х |
| TRM | | ✓ | Unavailable | - | - | Х | Х |
| CG | | ✓ | ✓ | ✓ | ✓ | Х | Х |
| PLL | | ✓ | ✓ | - | - | Х | Х |
| USB, ETHM | | ✓ | ✓ | ✓ (Note8) | ✓ (Note8) | Х | Х |
| External high-speed oscilla | ator (EHOSC) | ✓ | ✓ | - | - | Х | Х |
| Internal high-speed oscillator 1 (IHOSC1) | | ✓ | ✓ | - | - | Х | Х |
| Internal high-speed oscillator 2 (IHOSC2) | | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) | ✓ (Note5) |
| External Low-speed oscillator (ELOSC) | | ✓ | ✓ | ✓ | - | ✓ | - |
| RLM (Note7) | | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ |
| Code Flash | | Access Possible | | | Data hold | Doto hald | Data hald |
| Data Flash | | | Access Possible (Note6) | Data hold | | Data hold Data | Data hold |
| RAM | | | | | | Х | Х |
| Backup RAM | Backup RAM | | | | | Data hold | Data hold |

^{✓:} Operation is possible.

Note1: Check that the peripheral function is not operating and change to STOP 2 mode.

^{-:} If it shifts to the object mode, the clock to peripheral circuits stops automatically.

^{×:} If it shifts to the object mode, the power supply to the module is cut-off automatically. When returning, initialized by the reset.



- Note2: Stop SIWDT before shifting to the IDLE/STOP1 mode except protection A mode.
- Note3: A port state when the [RLMSHTDNOP]<PTKEEP> is set to "1" is held.
- Note4: This peripheral circuit can operate by using LTTMR as a sampling clock.
- Note5: This peripheral circuit can operate when [RLMLOSCCR]<POSCEN> is set to "1".
- Note6: It becomes a data hold when peripheral functions (HDMAC etc.) which carry out data access (R/W), except CPU, are not connected on the bus matrix.
- Note7: RLM means the registers to control the power, the low-speed oscillator, and others in the region where the power is not cut off.
- Note8: INTUSBOTGxWK can be used by USB, INTEMAMP can be used by ETHM.

1.3.2. Mode State Transition

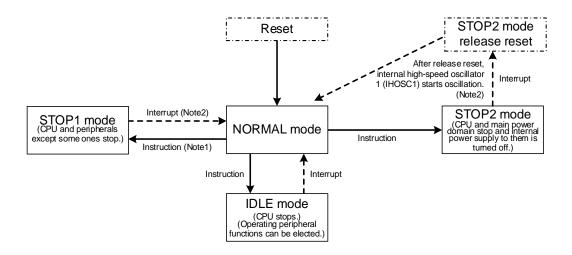


Figure 1.2 Change State Transition

Note1: Warm-up is required at returning. A warming-up time must be set in the previous mode (NORMAL mode) before entering to STOP1 mode.

Note2: When the TMPM4N Group (1) returns from STOP2 mode, the TMPM4N Group (1) branches to the interrupt service routine triggered by reset. When the TMPM4N Group (1) returns from STOP1 mode, the TMPM4N Group (1) branches to the interrupt service routine triggered by interrupt events.

1.3.2.1. IDLE Mode Transition Flow

Set up the following procedure at transition to IDLE mode.

Because IDLE mode is released by an interrupt, set the interrupt before transition to IDLE mode. For the interrupts that can be used to release the IDLE mode, refer to "1.2.4.1. Warming-up Timer for High-speed Oscillation". Disables unused interrupts and unavailable interrupts for release.

| | Transition procedure (from NORMAL mode) | | | | |
|---|---|---|--|--|--|
| 1 | [SIWDxEN] <wdte> = 0</wdte> | Disable SIWDT. | | | |
| 2 | [SIWDxCR] <wdcr[7:0]> = 0xB1</wdcr[7:0]> | Disable SIWDT. | | | |
| 3 | [FCSR0] <rdybsy> is read</rdybsy> | It waits until Flash will be in a Ready state (= 1). | | | |
| 4 | [CGSTBYCR] <stby[1:0]> = 00</stby[1:0]> | Low-power consumption mode selection is set to IDLE mode. | | | |
| 5 | [CGSTBYCR] <stby[1:0]> is read</stby[1:0]> | Confirm "00" is written to the register at the step 4. | | | |
| 6 | WFI command execution | Transit to IDLE mode | | | |

Note: When using the protection A mode of SIWDT, step 1 and 2 are not required.



1.3.2.2. STOP1 Mode Transition Flow

Set up the following procedure at transition to STOP1 mode.

Because STOP1 mode is released by an interrupt, set the interrupt before transition to STOP1 mode. For the interrupts that can be used to release the STOP1 mode, refer to "1.3.3.1. Release Source of Low-power Consumption Mode". Disables unused interrupts and unavailable interrupts for release STOP1 mode.

| | Transition procedure (from NORMAL mode) | | | | |
|----|---|---|--|--|--|
| 1 | [SIWDxEN] <wdte> = 0</wdte> | Disable SIWDT. | | | |
| 2 | [SIWDxCR] <wdcr[7:0]> = 0xB1</wdcr[7:0]> | Disable SIWDT. | | | |
| 3 | [FCSR0] <rdybsy> is read</rdybsy> | Wait until Flash becomes the Ready state (= 1). | | | |
| 4 | [CGWUPHCR] <wuef> is read</wuef> | Wait until the high-speed oscillation warming-up ends (= 0). | | | |
| 5 | [CGWUPHCR] <wuclk> = 0</wuclk> | Set the warming-up clock selection to internal high-speed oscillator 1 (IHOSC1). | | | |
| 5 | [CGWUPHCR] <wupt[15:4]> = 0x3C</wupt[15:4]> | Set the high-speed oscillation warming-up timer setting value of 163.4 µs (= 0x03C) or more. | | | |
| 6 | [CGSTBYCR] <stby[1:0]> = 01</stby[1:0]> | Low-power consumption mode selection is set to STOP1 mode. | | | |
| 7 | [CGPLL0SEL] <pll0sel> = 0</pll0sel> | Select the PLL for fsys to "PLL is unused (fosc)". | | | |
| 8 | [CGPLL0SEL] <pll0st> is read</pll0st> | Wait until the status of the PLL for fsys becomes "PLL is unused (fosc) (= 0)". | | | |
| 9 | [CGPLL0SEL] <pll0on> = 0</pll0on> | Stop PLL for fsys. | | | |
| 10 | [CGOSCCR] <ihosc1en> = 1</ihosc1en> | Enable the internal high-speed oscillator 1 (IHOSC1). | | | |
| 11 | [CGWUPHCR] <wuon> = 1</wuon> | Start the high-speed oscillation warming-up timer. | | | |
| 12 | [CGWUPHCR] <wuef> is read.</wuef> | Wait until a warming-up timer status flag becomes ends (= 0). | | | |
| 13 | [CGOSCCR] <oscsel> = 0</oscsel> | Set the high-speed oscillation selection for fosc to internal high-speed oscillator1 (IHOSC1). | | | |
| 14 | [CGOSCCR] <oscf> is read</oscf> | Wait until the high-speed oscillation selection status for fosc becomes internal high-speed oscillator1 (IHOSC1). (= 0). | | | |
| 15 | [CGOSCCR] <eoscen[1:0]> = 00</eoscen[1:0]> | Set the selection of an external oscillator operation to unused. | | | |
| 16 | [RLMLOSCCR] <poscen> = 0 or 1</poscen> | Setting for the internal high-speed oscillator 2 (IHOSC2). 0: Except following condition 1: When the LTTMR operates in STOP1 mode | | | |
| 17 | [CGOSCCR] <eoscen[1:0]> is read</eoscen[1:0]> | The register writing in step 15 is checked (= 00). | | | |
| 18 | [RLMLOSCCR] <poscf> is read</poscf> | Wait until the status of the internal high-speed oscillator 2 (IHOSC2) becomes the value set at step16. | | | |
| 19 | WFI command execution | Transit STOP1 mode. | | | |

Note: When using the protection A mode of SIWDT, step 1, 2, 16 and 18 are not required.



1.3.2.3. STOP2 Mode Transition Flow

Set up the following procedure at transition to STOP2 mode.

Because STOP2 mode is released by an interrupt, set the interrupt before transition to STOP2 mode. For the interrupts that can be used to release the STOP2 mode, refer to "1.3.3.1. Release Source of Low-power Consumption Mode". Disables unused interrupts and unavailable interrupts for release STOP2 mode.

| | Transition procedure | | | | |
|----|--|---|--|--|--|
| 1 | [SIWDxEN] <wdte> = 0 Disable SIWDT.</wdte> | | | | |
| 2 | [SIWDxCR] <wdcr[7:0]> = 0xB1</wdcr[7:0]> | Disable SIWDT. | | | |
| 3 | [FCSR0] <rdybsy> is read</rdybsy> | Wait until Flash becomes the ready state (= 1). | | | |
| 4 | [RLMSHTDNOP] <ptkeep> = 1</ptkeep> | I/O control signal is made to hold. | | | |
| 5 | [CGSTBYCR] <stby[1:0]> = 10</stby[1:0]> | Low-power consumption mode selection is set to STOP2 mode. | | | |
| 6 | [CGPLL0SEL] <pll0sel> = 0</pll0sel> | Select the PLL for fsys to "PLL is unused (fosc)". | | | |
| 7 | [CGPLL0SEL] <pll0st> is read</pll0st> | Wait until PLL status of fsys becomes off state (= 0). | | | |
| 8 | [CGPLL0SEL] <pll0on> = 0</pll0on> | Stop PLL for fsys. | | | |
| 9 | [CGWUPHCR] <wuclk> = 0 [CGWUPHCR]<wupt[15:4]> = 0x03C</wupt[15:4]></wuclk> | Set the warming-up clock selection to internal high-speed oscillator 1 (IHOSC1). Set the high-speed oscillation warming-up timer to 163.4 µs (= 0x03C) or more. | | | |
| 10 | [CGOSCCR] <ihosc1en> = 1</ihosc1en> | Enable the internal high-speed oscillator 1 (IHOSC1). | | | |
| 11 | [CGWUPHCR] <wuon> = 1</wuon> | Start the high-speed oscillation warming-up timer | | | |
| 12 | [CGWUPHCR] <wuef> is read.</wuef> | Wait until the warming-up timer status flag becomes ends (= 0). | | | |
| 13 | [CGOSCCR] <oscsel> = 0</oscsel> | Set the high-speed oscillation selection for fosc to internal high-speed oscillator1 (IHOSC1). | | | |
| 14 | [CGOSCCR] <oscf> is read</oscf> | Wait until the high-speed oscillation selection status for fosc becomes internal high-speed oscillator1 (IHOSC1) (= 0). | | | |
| 15 | [CGOSCCR] <eoscen[1:0]> = 00</eoscen[1:0]> | Set the selection of an external oscillator operation to unused. | | | |
| 16 | [RLMLOSCCR] <poscen> = 0 or 1</poscen> | Setting for the internal high-speed oscillator 2 (IHOSC2). 0: Except following condition 1: When the LTTMR operates in STOP2 mode | | | |
| 17 | [CGOSCCR] <eoscen[1:0]> is read</eoscen[1:0]> | The register writing in step 15 is checked (= 00). | | | |
| 18 | [RLMLOSCCR] <poscf> is read</poscf> | Wait until the status of internal high-speed oscillator 2 (IHOSC2) becomes the value set at step16. | | | |
| 19 | [RLMRSTFLG0] <stop2rstf> = 0 [RLMRSTFLG0]<pinrstf> = 0</pinrstf></stop2rstf> | STOP2 reset flag and reset pin flag are cleared (Note). | | | |
| 20 | WFI command execution | Transit to STOP2 mode. | | | |
| 21 | Jump instruction | Return to step 20. | | | |

Note: Refer to reference manual "Exception" for a reset flag register [RLMRSTFLG0].



1.3.3. Return Operation from Low-power Consumption Mode

1.3.3.1. Release Source of Low-power Consumption Mode

Interrupt, Non-Maskable Interrupt, and reset can perform release from a low-power consumption mode. The low-power consumption mode release source which can be used is decided by a low-power consumption mode. It shows the following table about details.

Table 1.11 Release Source List

| | | Low-power consumption mode | IDLE | STOP1 | STOP2 |
|---------|----------------------------------|---|------|-----------|-------|
| | | INT00 to INT15 (Note) | ✓ | ✓ | ✓ |
| | | INTRTC | ✓ | ✓ | ✓ |
| | | INTCECxRX, INTCECxTX | ✓ | ✓ | ✓ |
| | | INTISDx | ✓ | ✓ | ✓ |
| | | INTRMCx | ✓ | ✓ | ✓ |
| | | INTLTTMRx | ✓ | ✓ | ✓ |
| | | INTHDMAxTC, INTHDMAxERR | ✓ | - | - |
| | | INTMDMAxTC, INTMDMAxBERR, INTMDMAxDERR | ✓ | - | - |
| | | INT32Ax_A_CT, INT32Ax_B_Cx_CPC | ✓ | - | - |
| | | INTADxCP0, INTADxCP1, INTADxTRG, INTADxSGL, INTADxCNT, INTADxHP | ✓ | - | - |
| | | INTEMGx, INTOVVx, INTPWMx | ✓ | - | - |
| | Interrupt | INTTxRX, INTTxTX, INTTxERR | ✓ | - | - |
| | | INTSMIx | ✓ | - | - |
| | | INTUARTxRX, INTUARTxTX, INTUARTxERR | ✓ | - | - |
| Release | | INTFUARTx | ✓ | - | - |
| Source | | INTFLCRDY, INTFLDRDY | ✓ | - | - |
| | | INTI2CxNST, INTI2CxATX, INTI2CxBX, INTI2CxNA | ✓ | - | - |
| | | INTI2SxSI, INTI2SxSIERR, INTI2SxSO, INTI2SxSOERR | ✓ | - | - |
| | | INTFIR | ✓ | - | - |
| | | INTISSIxRX, INTSSIxTX, INTSSIxERR | ✓ | - | - |
| | | INTCANxRXD, INTCANxTXD, INTCANxGLB | ✓ | - | - |
| | | INTUSBOTGxWK, INTUSBOTGx | ✓ | ✓ (Note2) | - |
| | | INTEMAMP, INTEMA | ✓ | ✓ (Note2) | - |
| | SysTick interrupt | | ✓ | - | - |
| | Non-Maskable Interrupt (INTWDT0) | | ✓ | ✓ | - |
| | Non-Maskable Interrupt (INTLVD) | | ✓ | ✓ | ✓ |
| | Reset (SIWDT) | | ✓ | ✓ | - |
| | Reset (LVD) | | ✓ | ✓ | ✓ |
| | Reset (Of | -D) | ✓ | - | - |
| | Reset (RE | ESET_N pin) | ✓ | ✓ | ✓ |

^{✓:} It can be used for release. After release, the interrupt procedure will start.

Note1: INT00 to INT15 (External Interrupt 00 to 15) can select one of falling edge, rising edge and level. For details, please refer to reference manual "Exception".

Note2: INTUSBOTGxWK can be used by USB, INTEMAMP can be used by ETHM.

^{-:} It cannot be used for release.



- Released by an interrupt request
 When interrupt releases a low-power consumption mode, it is necessary to prepare so that interrupt may be
 detected by CPU. The interrupt used for release in STOP1 and STOP2 modes needs to set for detecting the
 interrupt by INTIF other than a setting of CPU.
- Released by Non-Maskable Interrupt (NMI)
 The factor of NMIs is SIWDT interrupt (INTWDT0, protection mode A only) and LVD interrupt (INTLVD).
- Released by reset
 The reset can perform release from all the low-power consumption modes.

 When released by reset, all registers will be initialized in NORMAL mode after release. For detail, refer to "3.2.8.1. Reset Factor and Reset Range".
- Released by SysTick interrupt
 SysTick interrupt is available only in IDLE mode.

Refer to "Interrupt" chapter of the reference manual "Exception" about the details of interrupt.



1.3.3.2. Warming Up at Release of Low-power Consumption Mode

Warming up may be required because of stability of an internal oscillator at the time of mode transition.

When the transition from STOP1 mode to NORMAL mode is done, an internal oscillator 1 (IHOSC1) is selected automatically and the warming-up timer is started. The output of a system clock is started after warming-up time elapsed.

For this reason, before executing the instruction which transit to the STOP1 mode, set up warming-up time by *[CGWUPHCR]*<WUPT[15:4]>. For the setting method, refer to "1.2.4.1. Warming-up Timer for High-speed Oscillation".

The following table shows the necessity of warming-up setup at the time of each operation mode transition.

Table 1.12 Warming Up

| Operation mode transition | Warming-up setup | | |
|--------------------------------|------------------|--|--|
| $NORMAL \rightarrow IDLE$ | Not required | | |
| $NORMAL \rightarrow STOP1$ | Not required | | |
| $NORMAL \to STOP2$ | Not required | | |
| $IDLE \longrightarrow NORMAL$ | Not required | | |
| STOP1 → NORMAL | Required | | |
| $STOP2 \to RESET \to NORMAL$ | Not required | | |



1.3.3.3. Restart Operation from STOP2 Mode

The restart operation flow from STOP2 mode release factor interrupt generating is as follows.

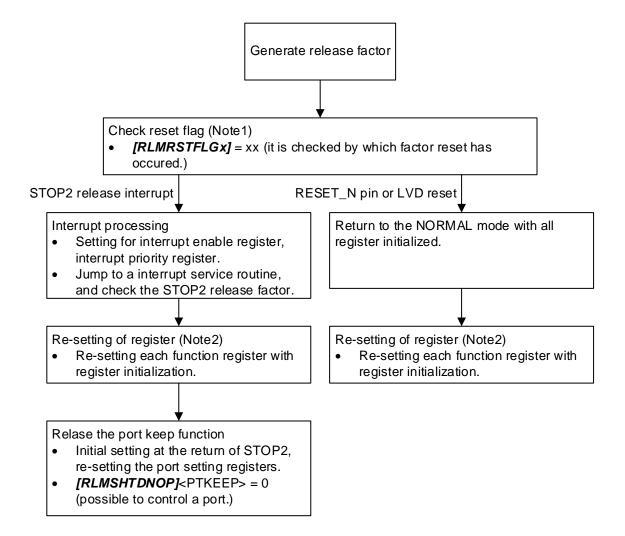


Figure 1.3 STOP2 Mode Restart Operation Flow

Note1: When STOP2 released by a RESET_N pin, as for a reset flag, both "STOP2 reset flag" and "reset pin flag" are set.

Note2: When STOP2 mode is released by LVD reset, as for a reset flag, both "STOP2 reset flag" and "reset pin flag" are materialized.

Note3: The reset range of registers is differ depending on the releasing STOP2 mode by an interrupt and by the reset of RESET_N pin or one of LVD. Refer to "3.2.8.1. Reset Factor and Reset Range" for detail.

36 / 94 2025-07-11 Rev. 1.4



1.3.4. Clock Operation by Mode Transition

The clock operation in case of mode transition is shown below.

1.3.4.1. NORMAL → IDLE → NORMAL Operation Mode Transition

CPU stops at IDLE mode. The clock supply to a peripheral function holds a setting state. Please perform operation/stop by the register of each peripheral function, a clock supply setting function, etc. if needed. Execution of warming-up operation is not performed at the time of the restart operation in NORMAL mode from IDLE mode.

After the transition instruction (WFI) execution which switch to IDLE mode, a program counter will indicate the next instruction and CPU stops. With a release source, it becomes a CPU start. In the case of an enable interrupt, the next instruction of the transition one (WFI) will be executed after the interrupt processing of release source.

1.3.4.2. NORMAL → **STOP1** → **NORMAL** Operation Mode Transition

When returning to NORMAL mode from the STOP1 mode, warming up is started automatically. Please set *[CGWUPHCR]*<WUPT[15:4]> to warming-up time (163.4µs or more) before transition to the STOP1 mode.

Note: When releasing factor is RESET_N pin or LVD reset, CPU operation is started after the internal processing time for reset and the waiting time till CPU running, not the warming-up time elapse.

When reset factor is not released after the internal processing time for reset elapses, starts measuring elapsed time after releasing reset factor. CPU operation is started after the waiting time till CPU running elapse.

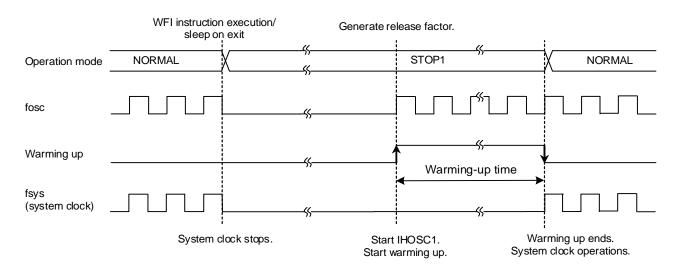


Figure 1.4 NORMAL \rightarrow STOP1 \rightarrow NORMAL Operation Mode Transition

37 / 94 2025-07-11



1.3.4.3. NORMAL → STOP2 → RESET → NORMAL Operation Mode Transition

Warming up is not performed when returning to NORMAL mode.

Even when returning to NORMAL mode by no reset, the CPU branches to the interrupt routine of reset A reset operation is performed to an internal main power domain after STOP2 mode released. However, a reset operation is not performed to a backup power domain.

Note: When releasing factor is RESET_N pin or LVD reset, CPU operation is started after the internal processing time for reset and the waiting time till CPU running, not the warming-up time elapse.

When reset factor is not released after the internal processing time for reset elapses, starts measuring elapsed time after releasing reset factor. CPU operation is started after the waiting time till CPU running elapse.

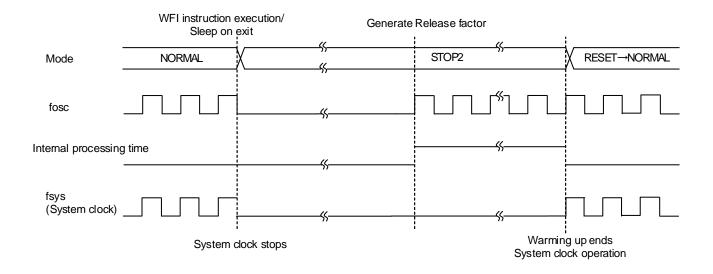


Figure 1.5 NORMAL → STOP2 → RESET → NORMAL Operation Mode Transition

38 / 94 2025-07-11



1.4. Registers

1.4.1. List of Registers

The register related to CG and its address information are shown below.

| Peripheral function | Channel/Unit | Base address | |
|--------------------------------------|--------------|--------------|------------|
| Clock Control and Operation Mode | CG | - | 0x40083000 |
| Low-speed oscillation/ power control | RLM | - | 0x4003E400 |

1.4.1.1. Clock Control and Operation Mode

| Register name | | Address (Base+) |
|---|--------------|-----------------|
| CG write protection register | [CGPROTECT] | 0x0000 |
| Oscillation control register | [CGOSCCR] | 0x0004 |
| System clock control register | [CGSYSCR] | 0x0008 |
| Standby control register | [CGSTBYCR] | 0x000C |
| PLL selection register for fsys | [CGPLL0SEL] | 0x0020 |
| High-speed oscillation warming-up register | [CGWUPHCR] | 0x0030 |
| Low-speed oscillation warming-up register | [CGWUPLCR] | 0x0034 |
| Middle-speed clock supply and stop register C for fsysm | [CGFSYSMENC] | 0x0044 |
| Middle-speed clock supply and stop register A for fsysm | [CGFSYSMENA] | 0x0048 |
| Middle-speed clock supply and stop register B for fsysm | [CGFSYSMENB] | 0x004C |
| High-speed clock supply and stop register A for fsysh | [CGFSYSENA] | 0x0050 |
| Clock supply and stop register for fc | [CGFCEN] | 0x0058 |
| Clock supply for ADC and Debug circuit Register | [CGSPCLKEN] | 0x005C |
| Function extension register 2 | [CGEXTEND2] | 0x0068 |

1.4.1.2. Low-speed Oscillation/power Control (Note1, Note2)

| Register name | Address (Base+) | |
|--|-----------------|--------|
| Low-speed oscillation and Internal high-speed oscillation 2 clock control register | [RLMLOSCCR] | 0x0000 |
| Power supply cut off control register | [RLMSHTDNOP] | 0x0001 |
| RLM write protection register | [RLMPROTECT] | 0x000F |

Note1: Byte accessible registers. Bit band access cannot be performed. Note2: When a register is rewritten, read the register to check rewriting.

In addition, when the reserved area is written, the initial value should be set.



1.4.2. Details of Register

1.4.2.1. [CGPROTECT] (CG Write Protection Register)

| Bit | Bit symbol | After reset | Туре | Function |
|------|--------------|-------------|------|---|
| 31:8 | - | 0 | R | Read as "0". |
| 7:0 | PROTECT[7:0] | 0xC1 | R/W | Control write protection for the CG registers (all registers except this register). 0xC1: Write protection for CG registers is disabled. Other than 0xC1: Write protection for CG registers is enabled. |

1.4.2.2. [CGOSCCR] (Oscillation Control Register)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|-------------|-------------|------|--|
| 31:17 | - | 0 | R | Read as "0". |
| 16 | IHOSC1F | 1 | R | Indicate the stability flag of an internal oscillation 1 for IHOSC1 (Note3) 0: Stopping or being in warming up 1: Stable oscillation |
| 15:13 | - | 0 | R | Read as "0". |
| 12 | - | 0 | R/W | Write as "0". |
| 11:10 | - | 0 | R | Read as "0". |
| 9 | OSCF | 0 | R | Indicate the selection status of a high-speed oscillator for fosc. 0: Internal high-speed oscillator 1 (IHOSC1) 1: External high-speed oscillator (EHOSC) |
| 8 | OSCSEL | 0 | R/W | Selects a high-speed oscillation for fosc. (Note1) 0: Internal high-speed oscillator 1 (IHOSC1) 1: External high-speed oscillator (EHOSC) |
| 7:4 | - | 0 | R | Read as "0". |
| 3 | - | 0 | R/W | Write as "0". |
| 2:1 | EOSCEN[1:0] | 00 | R/W | Select the operation of the external high-speed oscillation. (Note2) 00: External oscillation is not used. 01: Use an external high-speed oscillator (EHOSC). 10: Use an external high-speed clock input (EHCLKIN). 11: Reserved |
| 0 | IHOSC1EN | 1 | R/W | Internal high-speed oscillator 1 (IHOSC1) 0: Stop 1: Oscillation |

Note1: When the setting is modified, confirm whether the written value has been reflected to the *[CGOSCCR]* <OSCF> bit before executing the next operation.

Note2: When using the oscillator connection, set "01" to these bits (use an external high-speed oscillator.).

Note3: To wait stabilizing oscillation of an internal high-speed oscillator 1 (IHOSC1), use a warming-up timer and confirm *[CGWUPHCR]*<WUEF> instead of <IHOSCF1>.



1.4.2.3. [CGSYSCR] (System Clock Control Register)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|----------------|-------------|------|---|
| 31:30 | MCKSELPST[1:0] | 00 | R | Middle-speed prescaler clock (ΦT0m) selection status 00: <prck[3:0]> setting value (no division) 01: <prck[3:0]> setting value is divided by 2 Others: <prck[3:0]> setting value is divided by 4</prck[3:0]></prck[3:0]></prck[3:0]> |
| 29:28 | - | 0 | R | Read as "0". |
| 27:24 | PRCKST[3:0] | 0000 | R | High-speed prescaler clock (ΦT0h) selection status 0000: fc 0100: fc / 16 1000: fc / 256 0001: fc / 2 0101: fc / 32 1001: fc / 512 0010: fc / 4 0110: fc / 64 0011: fc / 8 0111: fc / 128 Others: Reserved |
| 23:22 | MCKSELGST[1:0] | 00 | R | Middle-speed system clock (fsysm) selection status 00: <gear[2:0]> setting value (no division) 01: <gear[2:0]> setting value is divided by 2 Others: <gear[2:0]> setting value is divided by 4</gear[2:0]></gear[2:0]></gear[2:0]> |
| 21:19 | - | 0 | R | Read as "0". |
| 18:16 | GEARST[2:0] | 000 | R | High-speed system clock (fsysh) gear selection status 000: fc 100: fc / 16 001: fc / 2 010: fc / 4 011: fc / 8 Others: Reserved |
| 15:12 | - | 0 | R | Read as "0". |
| 11:8 | PRCK[3:0] | 0000 | R/W | High-speed prescaler clock (ΦT0h) selection 0000: fc 0100: fc / 16 1000: fc / 256 0001: fc / 2 0101: fc / 32 1001: fc / 512 0010: fc / 4 0110: fc / 64 0011: fc / 8 0111: fc / 128 Others: Reserved Select a prescaler clock for the peripheral functions. |
| 7:6 | MCKSEL[1:0] | 00 | R/W | Middle-speed system clock (fsysm) and middle-speed prescaler clock (ΦT0m) selection 00: <gear[2:0]>, <prck[3:0]> setting values (no division) 01: <gear[2:0]>, <prck[3:0]> setting values are divided by 2. Others: <gear[2:0]>, <prck[3:0]> setting values are divided by 4. Maximum operating frequency of middle-speed system clock is 100 MHz.</prck[3:0]></gear[2:0]></prck[3:0]></gear[2:0]></prck[3:0]></gear[2:0]> |
| 5:3 | - | 0 | R | Read as "0". |
| 2:0 | GEAR[2:0] | 000 | R/W | High-speed system clock (fsysh) gear selection 000: fc 100: fc / 16 001: fc / 2 010: fc / 4 011: fc / 8 Others: Reserved |



1.4.2.4. [CGSTBYCR] (Standby Control Register)

| Bit | Bit symbol | After reset | Туре | Function |
|------|------------|-------------|------|--|
| 31:2 | - | 0 | R | Read as "0". |
| 1:0 | STBY[1:0] | 00 | R/W | Select a low-power consumption mode. 00: IDLE 01: STOP1 10: STOP2 11: Reserved |

1.4.2.5. [CGPLL0SEL] (PLL Selection Register for fsys)

| Bit | Bit symbol | After reset | Туре | Function |
|------|---------------|-------------|------|--|
| 31:8 | PLL0SET[23:0] | 0x000000 | R/W | PLL multiplication setup About a multiplication setup, refer to "1.2.5.2 Formula and Example of Setting of PLL Multiplication Value". |
| 7:3 | - | 0 | R | Read as "0". |
| 2 | PLL0ST | 0 | R | Indicate selection status of the clock for fsys. 0: fosc 1: fPLL |
| 1 | PLL0SEL | 0 | R/W | Select Clock selection for fsys 0: fosc 1: fPLL |
| 0 | PLL0ON | 0 | R/W | Select PLL operation for fsys 0: Stop 1: Oscillation |



1.4.2.6. [CGWUPHCR] (High-speed Oscillation Warming-up Register)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|------------|-------------|------|---|
| 31:20 | WUPT[15:4] | 0x800 | R/W | Set the upper 12 bits of the 16 bits of calculation values of the warm-up timer. About a setup of a warming-up timer, refer to "1.2.4.2 Warming-up Timer for Low-speed Oscillation". |
| 19:16 | WUPT[3:0] | 0x0 | R | Set the lower 4 bits of the 16 bits of calculation values of the warming-up timer. It is fixed to "0x0". |
| 15:9 | - | 0 | R | Read as "0". |
| 8 | WUCLK | 0 | R/W | Warming-up clock selection (Note1) 0: Internal high-speed oscillator 1 (IHOSC1) 1: External high-speed oscillator (EHOSC) |
| 7:2 | - | 0 | R | Read as "0". |
| 1 | WUEF | 0 | R | Indicate status of the warming-up timer. (Note2) 0: The end of Warming up 1: In warming-up operation |
| 0 | WUON | 0 | W | Control the warming-up timer. 0: don't care 1: Warming-up operation start. |

Note1: Use the internal high-speed oscillator 1 (IHOSC1) for warming up when returning from STOP1 mode. Do not use an external high-speed oscillator (EHOSC).

Note2: Do not modify the registers during the warming up ($\langle WUEF \rangle = 1$). Set the registers when $\langle WUEF \rangle = 0$.

1.4.2.7. [CGWUPLCR] (Low-speed Oscillation Warming-up Register)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|-------------|-------------|------|--|
| 31:27 | - | 0 | R | Read as "0". |
| 26:12 | WUPTL[18:4] | 0x4000 | R/W | Set the upper 15 bits of 19 bits of calculation values of the warming-up timer. About a setup of a warming-up timer, refer to "1.2.4.2. Warming-up Timer for Low-speed Oscillation". |
| 11:8 | WUPTL[3:0] | 0x0 | R | Sets the lower 4 bits of the 19 bits of calculation values of the warming-up timer. It is fixed to "0x0". |
| 7:2 | - | 0 | R | Read as "0". |
| 1 | WULEF | 0 | R | Indicate a status of the warming-up timer (Note) 0: The end of warming up 1: In warming-up operation |
| 0 | WULON | 0 | W | Control the warming-up timer 0: Don't care 1: Warming-up operation starts. |

Note: Do not modify the registers during the warming up (<WULEF> = 1). Set the registers when <WULEF> = 0.



1.4.2.8. [CGFSYSMENC] (Middle-speed Clock Supply and Stop Register C for fsysm)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|------------|-------------|---------|---|
| 31:17 | - | 0 | R | Read as "0". |
| | | | | Clock enable of T32A ch15 |
| 16 | IPMENC16 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| 15 | IPMENC15 | 0 | R/W | Clock enable of T32A ch14 0: Clock stop |
| 13 | IFIVIENCIS | U | IN/VV | 1: Clock supply |
| | | | | Clock enable of USB unit B |
| 14 | IPMENC14 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| 40 | IDMENIO42 | 0 | DAM | Clock enable of USB unit A |
| 13 | IPMENC13 | 0 | R/W | 0: Clock stop 1: Clock supply |
| | | | | Clock enable of CAN unit B |
| 12 | IPMENC12 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of CAN unit A |
| 11 | IPMENC11 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply Clock enable of ETHM unit A |
| 10 | IPMENC10 | 0 | R/W | 0: Clock stop |
| | | J | 1011 | 1: Clock supply |
| | | | | Clock enable of El2C ch4 |
| 9 | IPMENC09 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| 8 | IPMENC08 | 0 | R/W | Clock enable of El2C ch3 0: Clock stop |
| 0 | II WENCOO | U | 17/ / / | 1: Clock supply |
| | | | | Clock enable of EI2C ch2 |
| 7 | IPMENC07 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| 6 | IDMENCOS | 0 | DAM | Clock enable of EI2C ch1 |
| 0 | IPMENC06 | 0 | R/W | 0: Clock stop 1: Clock supply |
| | | | | Clock enable of EI2C ch0 |
| 5 | IPMENC05 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | IDIATIONA | | D 444 | Clock enable of TSSI ch1 |
| 4 | IPMENC04 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply Clock enable of TSSI ch0 |
| 3 | IPMENC03 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of FIR |
| 2 | IPMENC02 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply Clock enable of I2S ch1 |
| 1 | IPMENC01 | 0 | R/W | 0: Clock stop |
| ' | IPMENC01 | | K/VV | 1: Clock supply |
| | | | | Clock enable of I2S ch0 |
| 0 | IPMENC00 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |

Note1: Even if the initial value of the register is set to stop of the clock, the clock is supplied during the reset.

Note2: Write "0" for bit of function that does not exist in TMPM4GQ and TMPM4GN. For detail, refer to "1.5. Information for Each Product".



1.4.2.9. [CGFSYSMENA] (Middle-speed Clock Supply and Stop Register A for fsysm)

| Bit | Bit symbol | After reset | Туре | Function |
|-----|------------|-------------|------|--|
| 31 | IPMENA31 | 0 | R/W | Clock enable of I2C ch2 0: Clock stop 1: Clock supply |
| 30 | IPMENA30 | 0 | R/W | Clock supply Clock enable of I2C ch1 0: Clock stop 1: Clock supply |
| 29 | IPMENA29 | 0 | R/W | Clock enable of I2C ch0 0: Clock stop 1: Clock supply |
| 28 | IPMENA28 | 0 | R/W | Clock enable of UART ch5 0: Clock stop 1: Clock supply |
| 27 | IPMENA27 | 0 | R/W | Clock enable of UART ch4 0: Clock stop 1: Clock supply |
| 26 | IPMENA26 | 0 | R/W | Clock enable of UART ch3 0: Clock stop 1: Clock supply |
| 25 | IPMENA25 | 0 | R/W | Clock enable of UART ch2 0: Clock stop 1: Clock supply |
| 24 | IPMENA24 | 0 | R/W | Clock enable of UART ch1 0: Clock stop 1: Clock supply |
| 23 | IPMENA23 | 1 | R/W | Clock enable of UART ch0 0: Clock stop 1: Clock supply |
| 22 | IPMENA22 | 0 | R/W | Clock enable of TSPI ch8 0: Clock stop 1: Clock supply |
| 21 | IPMENA21 | 0 | R/W | Clock enable of TSPI ch7 0: Clock stop 1: Clock supply |
| 20 | IPMENA20 | 0 | R/W | Clock enable of TSPI ch6 0: Clock stop 1: Clock supply |
| 19 | IPMENA19 | 0 | R/W | Clock enable of T32A ch13 0: Clock stop 1: Clock supply |
| 18 | IPMENA18 | 0 | R/W | Clock enable of T32A ch12 0: Clock stop 1: Clock supply |
| 17 | IPMENA17 | 0 | R/W | Clock enable of T32A ch11 0: Clock stop 1: Clock supply |
| 16 | IPMENA16 | 0 | R/W | Clock enable of T32A ch10 0: Clock stop 1: Clock supply |
| 15 | IPMENA15 | 0 | R/W | Clock enable of T32A ch09 0: Clock stop 1: Clock supply |
| 14 | IPMENA14 | 0 | R/W | Clock enable of T32A ch08 0: Clock stop 1: Clock supply |
| 13 | IPMENA13 | 0 | R/W | Clock enable of T32A ch07 0: Clock stop 1: Clock supply |
| 12 | IPMENA12 | 0 | R/W | Clock enable of T32A ch06 0: Clock stop 1: Clock supply |



| Bit | Bit symbol | After reset | Туре | Function |
|-----|------------|-------------|------|--|
| 11 | IPMENA11 | 0 | R/W | Clock enable of T32A ch05 0: Clock stop 1: Clock supply |
| 10 | IPMENA10 | 0 | R/W | Clock enable of T32A ch04 0: Clock stop 1: Clock supply |
| 9 | IPMENA09 | 0 | R/W | Clock enable of T32A ch03 0: Clock stop 1: Clock supply |
| 8 | IPMENA08 | 0 | R/W | Clock enable of T32A ch02 0: Clock stop 1: Clock supply |
| 7 | IPMENA07 | 0 | R/W | Clock enable of T32A ch01 0: Clock stop 1: Clock supply |
| 6 | IPMENA06 | 1 | R/W | Clock enable of T32A ch00 0: Clock stop 1: Clock supply |
| 5 | IPMENA05 | 0 | R/W | Clock enable of DAC ch1 0: Clock stop 1: Clock supply |
| 4 | IPMENA04 | 0 | R/W | Clock enable of DAC ch0 0: Clock stop 1: Clock supply |
| 3 | IPMENA03 | 0 | R/W | Clock enable of ADC Unit A 0: Clock stop 1: Clock supply |
| 2 | IPMENA02 | 0 | R/W | Clock enable of FUART ch1 0: Clock stop 1: Clock supply |
| 1 | IPMENA01 | 0 | R/W | Clock enable of FUART ch0 0: Clock stop 1: Clock supply |
| 0 | IPMENA00 | 0 | R/W | Clock enable of MDMAC unit A 0: Clock stop 1: Clock supply |

Note1: Even if the initial value of the register is set to stop of the clock, the clock is supplied during the reset.

Note2: Write "0" for bit of function that does not exist in TMPM4GQ and TMPM4GN. For detail, refer to "1.5. Information for Each Product".



1.4.2.10. [CGFSYSMENB] (Middle-speed Clock Supply and Stop Register B for fsysm)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|------------|-------------|------|--|
| 31 | IPMENB31 | 1 | R/W | Clock enable of SIWDT 0: Clock stop |
| 30 | IPMENB30 | 1 | R/W | 1: Clock supply Clock enable of NBDIF 0: Clock stop |
| 29 | IPMENB29 | 1 | R/W | 1: Clock supply Write as "1". |
| 28 | IPMENB28 | 0 | R/W | Clock enable of TRGSEL 0: Clock stop 1: Clock supply |
| 27:25 | - | 0 | R | Read as "0". |
| 24 | IPMENB24 | 0 | R/W | Clock enable of A-PMD 0: Clock stop 1: Clock supply |
| 23 | IPMENB23 | 0 | R/W | Clock enable of OFD 0: Clock stop 1: Clock supply |
| 22 | IPMENB22 | 0 | R/W | Clock enable of TRM 0: Clock stop 1: Clock supply |
| 21 | IPMENB21 | 0 | R/W | Clock enable of PORT Y 0: Clock stop 1: Clock supply |
| 20 | IPMENB20 | 0 | R/W | Clock enable of PORT W 0: Clock stop 1: Clock supply |
| 19 | IPMENB19 | 0 | R/W | Clock enable of PORT V 0: Clock stop 1: Clock supply |
| 18 | IPMENB18 | 0 | R/W | Clock enable of PORT U 0: Clock stop 1: Clock supply |
| 17 | IPMENB17 | 0 | R/W | Clock enable of PORT T 0: Clock stop 1: Clock supply |
| 16 | IPMENB16 | 0 | R/W | Clock enable of PORT R 0: Clock stop 1: Clock supply |
| 15 | IPMENB15 | 0 | R/W | Clock enable of PORT P 0: Clock stop 1: Clock supply |
| 14 | IPMENB14 | 0 | R/W | Clock enable of PORT N 0: Clock stop 1: Clock supply |
| 13 | IPMENB13 | 0 | R/W | Clock enable of PORT M 0: Clock stop 1: Clock supply |
| 12 | IPMENB12 | 0 | R/W | Clock enable of PORT L 0: Clock stop 1: Clock supply |
| 11 | IPMENB11 | 0 | R/W | Clock enable of PORT K 0: Clock stop 1: Clock supply |
| 10 | IPMENB10 | 0 | R/W | Clock enable of PORT J 0: Clock stop 1: Clock supply |
| 9 | IPMENB09 | 1 | R/W | Clock enable of PORT H 0: Clock stop 1: Clock supply |



| Bit | Bit symbol | After reset | Туре | Function |
|-----|------------|-------------|------|-------------------------|
| | | | | Clock enable of PORT G |
| 8 | IPMENB08 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of PORT F |
| 7 | IPMENB07 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of PORT E |
| 6 | IPMENB06 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of PORT D |
| 5 | IPMENB05 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of PORT C |
| 4 | IPMENB04 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of PORT B |
| 3 | IPMENB03 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of PORT A |
| 2 | IPMENB02 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of I2C ch4 |
| 1 | IPMENB01 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |
| | | | | Clock enable of I2C ch3 |
| 0 | IPMENB00 | 0 | R/W | 0: Clock stop |
| | | | | 1: Clock supply |

Note1: Even if the initial value of the register is set to stop of the clock, the clock is supplied during the reset.

Note2: Write "0" for bit of function that does not exist in TMPM4NQ and TMPM4NN. For detail, refer to "1.5.

Information for Each Product".



1.4.2.11. [CGFSYSENA] (High-speed Clock Supply and Stop Register A for fsysh)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|------------|-------------|------|--|
| 31:10 | - | 0 | R | Read as "0". |
| 9 | IPENA09 | 0 | R/W | Clock enable of TSPI ch5 0: Clock stop 1: Clock supply |
| 8 | IPENA08 | 0 | R/W | Clock enable of TSPI ch4 0: Clock stop 1: Clock supply |
| 7 | IPENA07 | 0 | R/W | Clock enable of TSPI ch3 0: Clock stop 1: Clock supply |
| 6 | IPENA06 | 0 | R/W | Clock enable of TSPI ch2 0: Clock stop 1: Clock supply |
| 5 | IPENA05 | 0 | R/W | Clock enable of TSPI ch1 0: Clock stop 1: Clock supply |
| 4 | IPENA04 | 0 | R/W | Clock enable of TSPI ch0 0: Clock stop 1: Clock supply |
| 3 | IPENA03 | 0 | R/W | Clock enable of EBIF 0: Clock stop 1: Clock supply |
| 2 | IPENA02 | 0 | R/W | Clock enable of SMIF ch0 0: Clock stop 1: Clock supply |
| 1 | IPENA01 | 0 | R/W | Clock enable of HDMAC Unit B 0: Clock stop 1: Clock supply |
| 0 | IPENA00 | 0 | R/W | Clock enable of HDMAC Unit A 0: Clock stop 1: Clock supply |

Note1: Even if the initial value of the register is set to stop of the clock, the clock is supplied during the reset.

Note2: Write "0" for bit of function that does not exist in TMPM4NQ and TMPM4NN. For detail, refer to "1.5. Information for Each Product".



1.4.2.12. [CGFCEN] (Clock Supply and Stop Register for fc)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|------------|-------------|------|---|
| 31:28 | - | 0 | R | Read as "0". |
| 27 | FCIPEN27 | 0 | R/W | Clock enable of DNF Unit B 0: Clock stop 1: Clock supply |
| 26 | FCIPEN26 | 0 | R/W | Clock enable of DNF Unit A 0: Clock stop 1: Clock supply |
| 25:24 | - | 0 | R | Read as "0". |
| 23 | FCIPEN23 | 0 | R/W | Clock enable of OFD (Note1) 0: Clock stop 1: Clock supply |
| 22:0 | - | 0 | R | Read as "0". |

Note1: When use the monitor clock of fc, [CGFSYSMENB]<IPMENB23> and [CGFCEN]<FCIPEN23> should be enabled.

Note2: Even if the initial value of the register is set to stop of the clock, the clock is supplied during the reset.

Note3: Write "0" for bit of function that does not exist in TMPM4NQ and TMPM4NN. For detail, refer to "1.5. Information for Each Product ".

1.4.2.13. [CGSPCLKEN] (Clock Supply for ADC and Debug Circuit Register)

| Bit | Bit symbol | After reset | Туре | Function | | | |
|-------|------------|-------------|------|--|--|--|--|
| 31:17 | - | 0 | R | Read as "0". | | | |
| 16 | ADCKEN | 0 | R/W | Clock enable of ADC. 0: Clock stop 1: Clock supply | | | |
| 15:1 | - | 0 | R | Read as "0". | | | |
| 0 | TRCKEN | 0 | R/W | Clock enable of the trace function of debug circuit (TRACE and SWV). 0: Clock stop 1: Clock supply | | | |

Note1: Even if the initial value of the register is set to stop of the clock, the clock is supplied during the reset.

Note2: When setting this bit to "0" (clock stop), please make sure that AD conversion is stopped.



1.4.2.14. [CGEXTEND2] (Function Extension Register 2)

| Bit | Bit symbol | After reset | Туре | Function | | | |
|------|------------|-------------|------|---|--|--|--|
| 31:3 | - | 0 | R | Read as "0". | | | |
| 2 | RSV22 | 0 | R/W | MDMAC software reset It is generated with the continuous writes of "0", "1" and "0" in order. When this bit is written continuously in the order of "0", "1" and "0", MDMAC software reset is generated. After "1" is set, 4 cycles of middle-speed system clock (fsysm) or more should elapse before "0" is set. | | | |
| 1 | RSV21 | 0 | R/W | MDMAC descriptor error clear (Note) It is generated with the continuous writes of "0", "1" and "0" in order. MDMAC descriptor error is cleared by the sequential writes of "0", "1" and "0" in order. After "1" is set, 4 cycles of middle-speed system clock (fsysm) or more should elapse before "0" is set. | | | |
| 0 | RSV20 | 0 | R/W | MDMAC bus error clear (Note) It is generated with the continuous writes of "0", "1" and "0" in order. MDMAC bus error is cleared by the sequential writes of "0", "1" and "0" in order. After "1" is set, 4 cycles of middle-speed system clock (fsysm) or more should elapse before "0" is set. | | | |

Note: When an error flag should be cleared, it is necessary to assert the software reset <RSV22>, too.

1.4.2.15. [RLMLOSCCR] (Low-speed Oscillation and Internal High-speed Oscillation 2 Clock Control Register)

| Bit | Bit symbol | After reset | Туре | Function | | |
|-----|------------|-------------|------|--|--|--|
| 7:6 | - | 0 | R | Read as "0". | | |
| 5 | POSCF | 0 | R | ndicate the stability flag of internal oscillation for IHOSC2 0: Stopping or being in warming up 1: Stable oscillation | | |
| 4 | POSCEN | 0 | R/W | Internal high-speed oscillator 2 (IHOSC2) (Note3), (Note5) 0: Stop 1: Oscillation | | |
| 3 | - | 0 | R | Read as "0". | | |
| 2 | DRCOSCL | 0 | R/W | Selection of a low-speed clock. 0: External low-speed clock input (ELCLKIN) 1: External low-speed oscillator (ELOSC) | | |
| 1 | - | 0 | R/W | Write as "0". | | |
| 0 | XTEN | 0 | R/W | Selection of using a low-speed clock (Note4) 0: Not used 1: Used | | |

Note1: It is a register accessed per byte. Bit band access is not allowed.

Note2: It is initialized only by a power-on reset.

Note3: After changing the setting, make sure that [RLMLOSCCR]<POSCF> becomes "1" and then perform the next operation.

Note4: When <XTEN> is rewritten, read it to confirm rewriting result.

Note5: Even if <POSCEN> is write enabled by [RLMPROTECT], it cannot be written when [SIWDxOSCCR] <OSCPRO> = 1.



1.4.2.16. [RLMSHTDNOP] (Power Supply Cut Off Control Register)

| Bit | Bit symbol | After reset | Туре | Function | |
|-----|------------|-------------|------|--|--|
| 7 | - | 0 | R/W | Write as "0". | |
| 6:1 | - | 0 | R | Read as "0". | |
| 0 | PTKEEP | 0 | R/W | The I/O control signal in the STOP2 mode is held. 0: Control by Port. 1: Hold the state when it changes into "1" from "0". It is necessary to set this bit prior to the transition to STOP2 mode. | |

Note1: It is a register accessed per byte. Bit band access is not allowed.

Note2: When <PTKEEP> is rewritten, read it to confirm rewriting result.

1.4.2.17. [RLMPROTECT] (RLM Write Protection Register)

| Bit | Bit symbol | After reset | Туре | Function | |
|-----|--------------|-------------|------|--|--|
| 7:0 | PROTECT[7:0] | 0xC1 | R/W | Control write protection for RLM registers (all registers except this register). 0xC1: Write protection for RLM registers is disabled. Other than 0xC1: Write protection for RLM registers is enabled. | |

Note1: It is a register accessed per byte. Bit band access is not allowed.

Note2: When <PROTECT[7:0]> is rewritten, read it to confirm rewriting result.



1.5. Information for Each Product

The information about [CGFSYSENA], [CGFSYSMENA], [CGFSYSMENB], [CGFSYSMENC] and [CGFCEN] which are different according to each product is shown below.

1.5.1. [CGFSYSENA]

Table 1.13 Allocation of [CGFSYSENA] by Each Product

| | 1 4510 | 1.13 Allocation of | | | | |
|----------------|--------------|--------------------|-------------------------------|-------|-------|--------|
| Bit Bit symbol | | Destination | Channel number/ unit name/ | M4NR | M4NQ | M4NN |
| ы | Bit Syllibol | Destination | port name | WHITE | WHING | WITHIN |
| 31 | IPENA31 | - | - | - | - | - |
| 30 | IPENA30 | - | - | - | - | - |
| 29 | IPENA29 | - | - | - | - | - |
| 28 | IPENA28 | - | - | - | - | - |
| 27 | IPENA27 | - | - | - | - | - |
| 26 | IPENA26 | - | - | - | - | - |
| 25 | IPENA25 | - | - | - | - | - |
| 24 | IPENA24 | - | - | - | - | - |
| 23 | IPENA23 | - | - | - | - | - |
| 22 | IPENA22 | - | - | - | - | - |
| 21 | IPENA21 | - | - | - | - | - |
| 20 | IPENA20 | - | - | - | - | - |
| 19 | IPENA19 | - | - | - | - | - |
| 18 | IPENA18 | - | - | - | - | - |
| 17 | IPENA17 | - | - | - | - | - |
| 16 | IPENA16 | - | - | - | - | - |
| 15 | IPENA15 | - | - | - | - | - |
| 14 | IPENA14 | - | - | - | - | - |
| 13 | IPENA13 | - | - | - | - | - |
| 12 | IPENA12 | - | - | - | - | - |
| 11 | IPENA11 | - | - | - | - | - |
| 10 | IPENA10 | - | - | - | - | - |
| 9 | IPENA09 | | 5 | ✓ | ✓ | х |
| 8 | IPENA08 | | 4 | ✓ | ✓ | ✓ |
| 7 | IPENA07 | TODI | 3 | ✓ | ✓ | ✓ |
| 6 | IPENA06 | TSPI | 2 | ✓ | ✓ | ✓ |
| 5 | IPENA05 | | 1 | ✓ | ✓ | ✓ |
| 4 | IPENA04 | | 0 | ✓ | ✓ | ✓ |
| 3 | IPENA03 | EBIF | - | ✓ | ✓ | ✓ |
| 2 | IPENA02 | SMIF | 0 | ✓ | ✓ | ✓ |
| 1 | IPENA01 | HDMAC | В | ✓ | ✓ | ✓ |
| 0 | IPENA00 | TIDIVIAC | Α | ✓ | ✓ | ✓ |

^{✓:} Available, -: Not available



1.5.2. [CGFSYSMENA]

Table 1.14 Allocation of [CGFSYSMENA] by Each Product

| Bit | Bit symbol | Destination | Channel number/ unit name/ port name | M4NR | M4NQ | M4NN |
|-----|------------|-------------|--|------|------|------|
| 31 | IPMENA31 | | 2 | ✓ | ✓ | ✓ |
| 30 | IPMENA30 | I2C | 1 | ✓ | ✓ | ✓ |
| 29 | IPMENA29 | | 0 | ✓ | ✓ | ✓ |
| 28 | IPMENA28 | | 5 | ✓ | - | - |
| 27 | IPMENA27 | | 4 | ✓ | ✓ | - |
| 26 | IPMENA26 | - UART | 3 | ✓ | ✓ | - |
| 25 | IPMENA25 | UART | 2 | ✓ | ✓ | ✓ |
| 24 | IPMENA24 | | 1 | ✓ | ✓ | ✓ |
| 23 | IPMENA23 | | 0 | ✓ | ✓ | ✓ |
| 22 | IPMENA22 | | 8 | ✓ | - | - |
| 21 | IPMENA21 | TSPI | 7 | ✓ | ✓ | - |
| 20 | IPMENA20 | | 6 | ✓ | ✓ | - |
| 19 | IPMENA19 | | 13 | ✓ | ✓ | ✓ |
| 18 | IPMENA18 | | 12 | ✓ | ✓ | ✓ |
| 17 | IPMENA17 | | 11 | ✓ | ✓ | ✓ |
| 16 | IPMENA16 | | 10 | ✓ | ✓ | ✓ |
| 15 | IPMENA15 | | 9 | ✓ | ✓ | ✓ |
| 14 | IPMENA14 | | 8 | ✓ | ✓ | ✓ |
| 13 | IPMENA13 | T32A | 7 | ✓ | ✓ | ✓ |
| 12 | IPMENA12 | 132A | 6 | ✓ | ✓ | ✓ |
| 11 | IPMENA11 | | 5 | ✓ | ✓ | ✓ |
| 10 | IPMENA10 | | 4 | ✓ | ✓ | ✓ |
| 9 | IPMENA09 | | 3 | ✓ | ✓ | ✓ |
| 8 | IPMENA08 | | 2 | ✓ | ✓ | ✓ |
| 7 | IPMENA07 | | 1 | ✓ | ✓ | ✓ |
| 6 | IPMENA06 | | 0 | ✓ | ✓ | ✓ |
| 5 | IPMENA05 | DAC | 1 | ✓ | ✓ | ✓ |
| 4 | IPMENA04 | DAC | 0 | ✓ | ✓ | ✓ |
| 3 | IPMENA03 | ADC | Α | ✓ | ✓ | ✓ |
| 2 | IPMENA02 | FUART | 1 | ✓ | ✓ | - |
| 1 | IPMENA01 | TOAKT | 0 | ✓ | ✓ | ✓ |
| 0 | IPMENA00 | MDMAC | А | ✓ | ✓ | ✓ |

^{✓:} Available, -: Not available



1.5.3. [CGFSYSENB]

Table 1.15 Allocation of [CGFSYSMENB] by Each Product

| Bit | Bit symbol | Destination | Channel number/ unit name/ port name | M4NR | M4NQ | M4NN |
|-----|------------|-------------|--|------|----------|------|
| 31 | IPMENB31 | SIWDT | 0 | ✓ | ✓ | ✓ |
| 30 | IPMENB30 | NBDIF | - | ✓ | ✓ | ✓ |
| 29 | IPMENB29 | - (Note) | - | - | - | - |
| 28 | IPMENB28 | TRGSEL | 0 | ✓ | ✓ | ✓ |
| 27 | IPMENB27 | - | - | - | - | - |
| 26 | IPMENB26 | - | - | - | - | - |
| 25 | IPMENB25 | - | - | - | - | - |
| 24 | IPMENB24 | A-PMD | 0 | ✓ | ✓ | ✓ |
| 23 | IPMENB23 | OFD | - | ✓ | ✓ | ✓ |
| 22 | IPMENB22 | TRM | - | ✓ | ✓ | ✓ |
| 21 | IPMENB21 | | Y | ✓ | ✓ | ✓ |
| 20 | IPMENB20 | | W | ✓ | - | - |
| 19 | IPMENB19 | | V | ✓ | ✓ | - |
| 18 | IPMENB18 | | U | ✓ | - | - |
| 17 | IPMENB17 | | Т | ✓ | ✓ | ✓ |
| 16 | IPMENB16 | | R | ✓ | ✓ | - |
| 15 | IPMENB15 | | Р | ✓ | ✓ | ✓ |
| 14 | IPMENB14 | | N | ✓ | ✓ | ✓ |
| 13 | IPMENB13 | | M | ✓ | ✓ | - |
| 12 | IPMENB12 | PORT | L | ✓ | ✓ | ✓ |
| 11 | IPMENB11 | PORT | K | ✓ | ✓ | ✓ |
| 10 | IPMENB10 | | J | ✓ | - | - |
| 9 | IPMENB09 | | Н | ✓ | ✓ | ✓ |
| 8 | IPMENB08 | | G | ✓ | ✓ | ✓ |
| 7 | IPMENB07 | | F | ✓ | ✓ | ✓ |
| 6 | IPMENB06 | | E | ✓ | ✓ | ✓ |
| 5 | IPMENB05 | | D | ✓ | ✓ | ✓ |
| 4 | IPMENB04 | | С | ✓ | ✓ | - |
| 3 | IPMENB03 | | В | ✓ | ✓ | ✓ |
| 2 | IPMENB02 | | A | ✓ | ✓ | ✓ |
| 1 | IPMENB01 | 120 | 4 | ✓ | ✓ | - |
| 0 | IPMENB00 | I2C | 3 | ✓ | ✓ | - |

. \checkmark : Available, -: Not available

Note: Write as "1" (Clock supply).



1.5.4. [CGFSYSENC]

Table 1.16 Allocation of [CGFSYSMENC] by Each Product

| | | | Channel number/ | | | |
|-----|------------|-------------|-------------------------|------|------|------|
| Bit | Bit symbol | Destination | unit name/ port name | M4NR | M4NQ | M4NN |
| 31 | IPMENC31 | - | - | - | - | - |
| 30 | IPMENC30 | - | - | - | - | - |
| 29 | IPMENC29 | - | - | - | - | - |
| 28 | IPMENC28 | - | - | - | _ | - |
| 27 | IPMENC27 | - | - | - | _ | - |
| 26 | IPMENC26 | - | - | - | - | - |
| 25 | IPMENC25 | - | - | - | - | - |
| 24 | IPMENC24 | - | - | - | - | - |
| 23 | IPMENC23 | - | - | - | - | - |
| 22 | IPMENC22 | - | - | - | - | - |
| 21 | IPMENC21 | - | - | - | - | - |
| 20 | IPMENC20 | - | - | - | - | - |
| 19 | IPMENC19 | - | - | - | - | - |
| 18 | IPMENC18 | - | - | - | - | - |
| 17 | IPMENC17 | - | - | - | - | - |
| 16 | IPMENC16 | T004 | 15 | ✓ | ✓ | ✓ |
| 15 | IPMENC15 | T32A | 14 | ✓ | ✓ | ✓ |
| 14 | IPMENC14 | 1100 | В | ✓ | ✓ | - |
| 13 | IPMENC13 | USB | А | ✓ | ✓ | ✓ |
| 12 | IPMENC12 | CAN | В | ✓ | ✓ | ✓ |
| 11 | IPMENC11 | CAN | A | ✓ | ✓ | ✓ |
| 10 | IPMENC10 | ETHM | A | ✓ | ✓ | ✓ |
| 9 | IPMENC09 | | 4 | ✓ | ✓ | - |
| 8 | IPMENC08 | | 3 | ✓ | ✓ | - |
| 7 | IPMENC07 | EI2C | 2 | ✓ | ✓ | ✓ |
| 6 | IPMENC06 | | 1 | ✓ | ✓ | ✓ |
| 5 | IPMENC05 | | 0 | ✓ | ✓ | ✓ |
| 4 | IPMENC04 | Teel | 1 | ✓ | - | - |
| 3 | IPMENC03 | TSSI | 0 | ✓ | ✓ | ✓ |
| 2 | IPMENC02 | FIR | 0 | ✓ | ✓ | ✓ |
| 1 | IPMENC01 | I2S | 1 | ✓ | ✓ | ✓ |
| 0 | IPMENC00 | 120 | 0 | ✓ | ✓ | ✓ |

✓: Available, -: Not available



1.5.5. [CGFCEN]

Table 1.17 Allocation of [CGFCEN] by Each Product

| Bit | Bit symbol | Destination | Channel number/ unit name/ port name | M4NR | M4NQ | M4NN |
|-----|------------|-------------|--|------|------|------|
| 31 | FCIPEN31 | - | - | - | - | - |
| 30 | FCIPEN30 | - | - | - | - | - |
| 29 | FCIPEN29 | - | - | - | - | - |
| 28 | FCIPEN28 | - | - | - | - | - |
| 27 | FCIPEN27 | DNE | В | ✓ | ✓ | ✓ |
| 26 | FCIPEN26 | DNF | А | ✓ | ✓ | ✓ |
| 25 | FCIPEN25 | - | - | - | - | - |
| 24 | FCIPEN24 | - | - | - | - | - |
| 23 | FCIPEN23 | OFD | - | ✓ | ✓ | ✓ |
| 22 | FCIPEN22 | - | - | - | - | - |
| 21 | FCIPEN21 | - | - | - | - | - |
| 20 | FCIPEN20 | - | - | - | - | - |
| 19 | FCIPEN19 | - | - | - | - | - |
| 18 | FCIPEN18 | - | - | - | - | - |
| 17 | FCIPEN17 | - | - | - | - | - |
| 16 | FCIPEN16 | • | - | - | - | 1 |
| 15 | FCIPEN15 | - | - | - | - | - |
| 14 | FCIPEN14 | - | - | - | - | - |
| 13 | FCIPEN13 | - | - | - | - | - |
| 12 | FCIPEN12 | - | - | - | - | - |
| 11 | FCIPEN11 | - | - | - | - | - |
| 10 | FCIPEN10 | • | - | - | - | 1 |
| 9 | FCIPEN09 | • | - | - | - | 1 |
| 8 | FCIPEN08 | • | - | - | - | 1 |
| 7 | FCIPEN07 | • | - | - | - | 1 |
| 6 | FCIPEN06 | - | - | - | - | - |
| 5 | FCIPEN05 | - | - | - | - | - |
| 4 | FCIPEN04 | • | - | - | - | - |
| 3 | FCIPEN03 | - | - | - | - | - |
| 2 | FCIPEN02 | - | - | - | - | - |
| 1 | FCIPEN01 | - | - | - | - | - |
| 0 | FCIPEN00 | - | - | - | - | - |

^{✓:} Available, -: Not available



2. Memory Map

2.1. Outline

The memory maps for TMPM4N group (1) are based on the Cortex-M4 (with FPU) processor core memory map. The internal ROM, internal RAM, and special function registers (SFR) of TMPM4N Group (1) are mapped to the Code, SRAM, and peripheral regions of the Cortex-M4 (with FPU) respectively. The special function register (SFR) means the control registers of all input/output ports and peripheral functions.

The CPU register region is the processor core's internal register region.

For more information on each region, refer to "Arm Cortex-M4 Processor Technical Reference Manual".

Note that access to regions indicated as "Fault" causes a bus fault if bus faults are enabled, or causes a hard fault if bus faults are disabled. Also, do not access the vendor-specific region.



2.1.1. TMPM4NxF20

• Code Flash: 2048KB

• RAM: 256KB+2KB (Backup RAM)

• Data Flash: 32KB

Target products: TMPM4NRF20FG, TMPM4NRF20XBG, TMPM4GNF20FG, TMPM4NQF20XBG,

TMPM4NNF20FG

| 0xFFFFFFF | Vendor-Specific | | 0xFFFFFFF | Vendor-Specific |
|--------------------------|------------------------------------|--------------|--------------------------|------------------------------------|
| 0xE0100000 | | <u>—</u> | 0xE0100000 | |
| 0xE0000000 | CPU Register Region | System level | 0xE0000000 | CPU Register Region |
| 0xA8000000 | Fault | /ster | 0xA8000000 | Fault |
| 0xA0000000 | Serial memory interface area | Ś | 0xA0000000 | Serial memory interface area |
| 0x80000000 | Fault | | 0x80000000 | Fault |
| 0x60000000 | External bus interface area | | 0x60000000 | External bus interface area |
| 0x5E200000 | Fault | | 0x5E200000 | Fault |
| 0x5E000000 | Code Flash (Mirror 2048KB) | | 0x5E000000 | Code Flash (Mirror 2048KB) |
| 0x5DFF0000 | Flash (SFR) | <u>a</u> | 0x5DFF0000 | Flash (SFR) |
| 0x44000000 | Fault | Peripheral | 0x44000000 | Fault |
| 0x42000000 | Bit Band Alias (SFR) | _ | 0x42000000 | Bit Band Alias (SFR) |
| | Fault | | | Fault |
| 0x40180000 | | | 0x40180000 | |
| 0x40000000 | SFR | | 0x40000000 | SFR |
| | | | 025,00000 | Fault |
| 0x3F7F9800 | Fault | | 0x3F800000 0x3F7F8000 | Boot ROM (Mirror) |
| | | | 0.31 /1 0000 | ` ' |
| 0x30008000 | | | 0x30008000 | Fault |
| | Data Flash | | | Data Flash |
| 0x30000000 | (32KB) | | 0x30000000 0x221C0000 | (32KB) |
| 0x221C0000 | Fault | | 0x221C0000 | Fault |
| 0x22000000 | Bit Band Alias (RAM/Backup RAM) | SRAM | 0x22000000 | Bit Band Alias (RAM/Backup RAM) |
| 0×20040800 | Fault | •, | 0v20040800 | Fault |
| 0x20040800 0x20040000 | Backup RAM (2KB) | | 0x20040800 0x20040000 | Backup RAM (2KB) |
| 0x20040000 | RAM5 (32KB) | | 0x20038000 | RAM5 (32KB) |
| 0x20030000 | RAM4 (32KB) | | 0x20030000 | RAM4 (32KB) |
| 0x20000000 | RAM3 (32KB) | | 0x20030000 | RAM3 (32KB) |
| 0x20002000 | RAM2 (32KB) | | 0x20002000 | RAM2 (32KB) |
| 0x20010000 | RAM1 (64KB) | | 0x20010000 | RAM1 (64KB) |
| 0x20000000 | RAM0 (64KB) | | 0x20000000 | RAM0 (64KB) |
| 0x00200000 | Fault | ٥ | | Fault |
| 0x00000000 | Code Flash (2048KB) | Code | 0x00008000 0x00000000 | Boot ROM (32KB) |
| , | | | | |

Single chip mode

Figure 2.1 TMPM4NxF20

59 / 94 2025-07-11 Rev. 1.4

Single Boot mode



2.1.2. TMPM4NxF15

• Code Flash: 1536KB

• RAM: 256KB+2KB (Backup RAM)

• Data Flash: 32KB

• Target products: TMPM4NRF15FG, TMPM4NRF15XBG, TMPM4NQF15FG, TMPM4NQF15XBG,

TMPM4NNF15FG

| 0xFFFFFFF | Vendor-Specific | | 0xFFFFFFF | Vendor-Specific |
|-------------|-------------------------------|--------------|-------------|-------------------------------|
| 0xE0100000 | vender openine | <u></u> | 0xE0100000 | vendor-opeone |
| 0xE0000000 | CPU Register Region | System level | 0xE0000000 | CPU Register Region |
| 0xA8000000 | Fault | sten | 0xA8000000 | Fault |
| 0xA0000000 | Serial memory interface area | Ś | 0xA0000000 | Serial memory interface area |
| 0x80000000 | Fault | | 0×80000000 | Fault |
| 0x60000000 | External bus interface area | | 0x60000000 | External bus interface area |
| 0x5E200000 | Fault | | 0x5E200000 | Fault |
| 0x5E180000 | Reserved | | 0x5E180000 | Reserved |
| 0.002.00000 | 110001100 | | 0.02.100000 | 110001104 |
| 0x5E000000 | Code Flash (Mirror 1536KB) | | 0x5E000000 | Code Flash (Mirror 1536KB) |
| 0x5DFF0000 | Flash (SFR) | ral | 0x5DFF0000 | Flash (SFR) |
| | , , | ohe | | , , |
| 0x44000000 | Fault | Peripheral | 0x44000000 | Fault |
| | Bit Band Alias | | | Bit Band Alias |
| | (SFR) | | | (SFR) |
| 0x42000000 | | | 0x42000000 | |
| 0x40180000 | Fault | | 0x40180000 | Fault |
| | SFR | | | SFR |
| 0x40000000 | SFK | | 0x40000000 | SFK |
| | | | | |
| | | | 0x3F800000 | Fault |
| 0x3F7F9800 | Fault | | 0x3F7F8000 | Boot ROM (Mirror) |
| | | | 0.000 | ` ′ |
| 0x30008000 | | | 0x30008000 | Fault |
| | Data Flash | | | Data Flash |
| 0x30000000 | (32KB) | | 0x30000000 | (32KB) |
| 0x221C0000 | Fault | | 0x221C0000 | Fault |
| | | | | |
| | Bit Band Alias | Σ | | Bit Band Alias |
| | (RAM/Backup RAM) | SRAN | | (RAM/Backup RAM) |
| 0x22000000 | | S | 0x22000000 | |
| 0x20040800 | Fault | | 0x20040800 | Fault |
| 0x20040000 | Backup RAM (2KB) | | 0x20040000 | Backup RAM (2KB) |
| 0x20038000 | RAM5 (32KB) | | 0x20038000 | RAM5 (32KB) |
| 0x20030000 | RAM4 (32KB) | | 0x20030000 | RAM4 (32KB) |
| 0x20002800 | RAM3 (32KB) | | 0x20002800 | RAM3 (32KB) |
| 0x20002000 | RAM2 (32KB) | | 0x20002000 | RAM2 (32KB) |
| 0x20010000 | RAM1 (64KB) | | 0x20010000 | RAM1 (64KB) |
| 0x20000000 | RAM0 (64KB) | | 0x20000000 | RAM0 (64KB) |
| | Fault | | | |
| 0x00200000 | | 40 | | |
| 0x00180000 | Reserved | Code | | Fault |
| | Code Flash | ŏ | | |
| | (1536KB) | | 0x00008000 | B DOL: //-/ |
| 0x00000000 | | | 0x00000000 | Boot ROM (32KB) |

Single chip mode

Single Boot mode

Figure 2.2 TMPM4NxF15

60 / 94 2025-07-11



2.1.3. TMPM4NxF10

• Code Flash: 1024KB

• RAM: 256KB+2KB (Backup RAM)

• Data Flash: 32KB

Target products: TMPM4NRF10FG, TMPM4NRF10XBG, TMPM4NQF10FG, TMPM4NQF10XBG,

TMPM4NNF10FG

| 0xFFFFFFF | Vendor-Specific | | 0xFFFFFFF | Vendor-Specific |
|--------------------------|------------------------------------|--------------|--------------------------|------------------------------------|
| 0xE0100000 | | Θ | 0xE0100000 | |
| 0xE0000000 | CPU Register Region | System level | 0xE0000000 | CPU Register Region |
| 0xA8000000 | Fault | /ster | 0xA8000000 | Fault |
| 0xA0000000 | Serial memory interface area | (S | 0xA0000000 | Serial memory interface area |
| 0x80000000 | Fault | | 0x80000000 | Fault |
| 0x60000000 | External bus interface area | | 0x60000000 | External bus interface area |
| 0x5E100000 | Fault | | 0x5E100000 | Fault |
| 0x5E000000 | Code Flash (Mirror 1024KB) | | 0x5E000000 | Code Flash (Mirror 1024KB) |
| 0x5DFF0000 | Flash (SFR) | eral | 0x5DFF0000 | Flash (SFR) |
| 0x44000000 | Fault | Peripheral | 0x44000000 | Fault |
| 0x42000000 | Bit Band Alias (SFR) | | 0x42000000 | Bit Band Alias (SFR) |
| | Fault | | | Fault |
| 0x40180000 | | | 0x40180000 | |
| 0x40000000 | SFR | | 0x40000000 | SFR |
| | | | 0x3F800000 | Fault |
| 0x3F7F9800 | Fault | | 0x3F7F8000 | Boot ROM (Mirror) |
| | | | | Fault |
| 0x30008000 | D . E | | 0x30008000 | |
| 0x30000000 | Data Flash (32KB) | | 0x30000000 | Data Flash (32KB) |
| 0x221C0000 | Fault | | 0x221C0000 | Fault |
| 0X22 100000 | raun | | 0,122 1 00000 | raun |
| 0x22000000 | Bit Band Alias (RAM/Backup RAM) | SRAM | 0x22000000 | Bit Band Alias (RAM/Backup RAM) |
| | Fault | U) | | Fault |
| 0x20040800 | | | 0x20040800 | |
| 0x20040000 | Backup RAM (2KB) RAM5 (32KB) | | 0x20040000 | Backup RAM (2KB) |
| 0x20038000 0x20030000 | RAM4 (32KB) | | 0x20038000 0x20030000 | RAM5 (32KB) RAM4 (32KB) |
| 0x20030000 0x20002800 | RAM3 (32KB) | | 0x20030000 | RAM3 (32KB) |
| 0x20002800 0x20002000 | RAM2 (32KB) | | 0x20002800 | RAM2 (32KB) |
| 0x20010000 | RAM1 (64KB) | | 0x20010000 | RAM1 (64KB) |
| 0x20000000 | RAM0 (64KB) | | 0x20000000 | RAM0 (64KB) |
| 0x00100000 | Fault Code Flash | Code | 0x00008000 | Fault |
| 0x00000000 | (1024KB) | | 0x00000000 | Boot ROM (32KB) |
| ' | | | | |

Single chip mode Single Boot mode

Figure 2.3 TMPM4NxF10



2.1.4. TMPM4NxFD

• Code Flash: 512KB

• RAM: 192KB+2KB (Backup RAM)

• Data Flash: 32KB

• Target products: TMPM4NRFDFG, TMPM4NRFDXBG, TMPM4NQFDFG, TMPM4NQFDXBG,

TMPM4NNFDFG

| 0xFFFFFFFF 0xE0100000 | Vendor-Specific | - | 0xFFFFFFFF 0xE0100000 | Vendor-Specific |
|--------------------------|------------------------------------|--------------|--------------------------|------------------------------------|
| 0xE0000000 | CPU Register Region | System level | 0xE0000000 | CPU Register Region |
| 0xA8000000 | Fault | sten | 0xA8000000 | Fault |
| 0xA0000000 | Serial memory interface area | Sy | 0xA0000000 | Serial memory interface area |
| 0x80000000 | Fault | | 0x80000000 | Fault |
| 0x60000000 | External bus interface area | | 0x60000000 | External bus interface area |
| | Fault | | | Fault |
| 0x5E100000 | | | 0x5E100000 | |
| 0x5E080000 | Reserved | | 0x5E080000 | Reserved |
| 0x5E000000 | Code Flash (Mirror 512KB) | | 0x5E000000 | Code Flash (Mirror 512KB) |
| 0x5DFF0000 | Flash (SFR) | ieral | 0x5DFF0000 | Flash (SFR) |
| 0x44000000 | Fault | Peripheral | 0x44000000 | Fault |
| | Bit Band Alias | _ | | Bit Band Alias |
| 0x42000000 | (SFR) | | 0x42000000 | (SFR) |
| 0X-12000000 | Fault | | 0X4200000 | Fault |
| 0x40180000 | 1 aut | | 0x40180000 | 1 duit |
| 0x40000000 | SFR | | 0x40000000 | SFR |
| | | | 0x3F800000 | Fault |
| 0x3F7F9800 | Fault | | 0x3F7F8000 | Boot ROM (Mirror) |
| 0x30008000 | | | 0x30008000 | Fault |
| 0x30000000 | Data Flash (32KB) | | 0x30000000 | Data Flash (32KB) |
| 0x221C0000 | Fault | | 0x221C0000 | Fault |
| 0x22000000 | Bit Band Alias (RAM/Backup RAM) | SRAM | 0x22000000 | Bit Band Alias (RAM/Backup RAM) |
| 0x20040800 | Fault | | 0x20040800 | Fault |
| 0x20040000 | Backup RAM (2KB) | | 0x20040000 | Backup RAM (2KB) |
| 0x20038000 | RAM5 (32KB) | | 0x20038000 | RAM5 (32KB) |
| 0x20030000 | RAM4 (32KB) | | 0x20030000 | RAM4 (32KB) |
| 0x20002000 | Reserved | | 0x20002000 | Reserved |
| 0x20010000 | RAM1 (64KB) | | 0x20010000 | RAM1 (64KB) |
| 0x20000000 | RAM0 (64KB) | | 0x20000000 | RAM0 (64KB) |
| 0x00100000 0x00080000 | Fault Reserved | Code | 0x00008000 | Fault |
| 0x00000000 | Code Flash (512KB) | | 0x00000000 | Boot ROM (32KB) |
| | Single chip mode | | | Single Boot mode |

Single chip mode Single Boot mode

Figure 2.4 TMPM4NxF10



2.2. Bus Matrix

TMPM4N Group (1) have the main managers consisted of the CPU core and high-speed DMA controllers (HDMAC) and sub manager consisted of a multi-function DMA controller (MDMAC) and NBDIF.

The main managers are connected to the subordinate ports (S1 to S5) of the bus matrix. They are connected to the peripheral functions and middle-speed clock domain via manager ports (M0 to M15) through the symbol "o" and "o" which mean the connection in a bus matrix.

The sub managers are connected to the subordinate ports (SS0 to SS4) of the bus matrix. They are connected to the peripheral functions and high-speed clock domain via manager ports (SM0 to SM13) through the symbol "o" and "•" which mean the connection in a bus matrix.

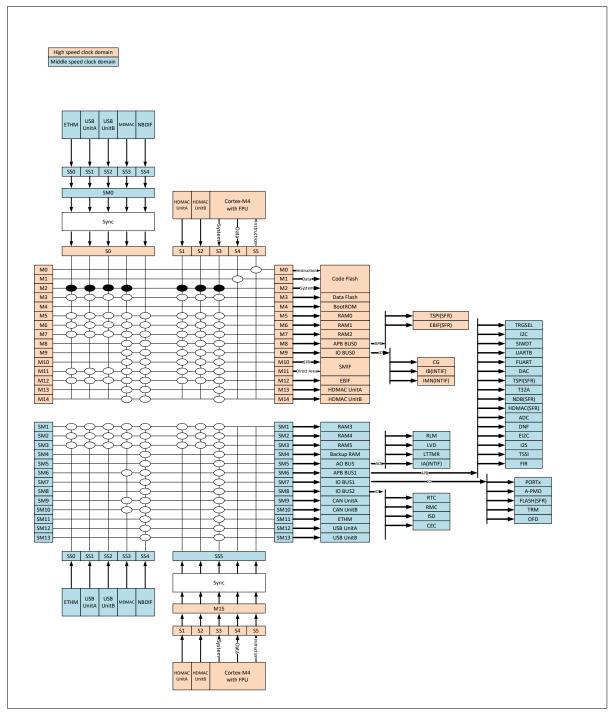
"•" shows a connection to a mirror area.

When multiple subordinates are connected to the same manager line in the bus matrix and multiple subordinates are accessed at the same time, the access to the subordinate from the manager with the smallest subordinate number is prioritized.



2.2.1. Continuation

2.2.1.1. Single Chip Mode



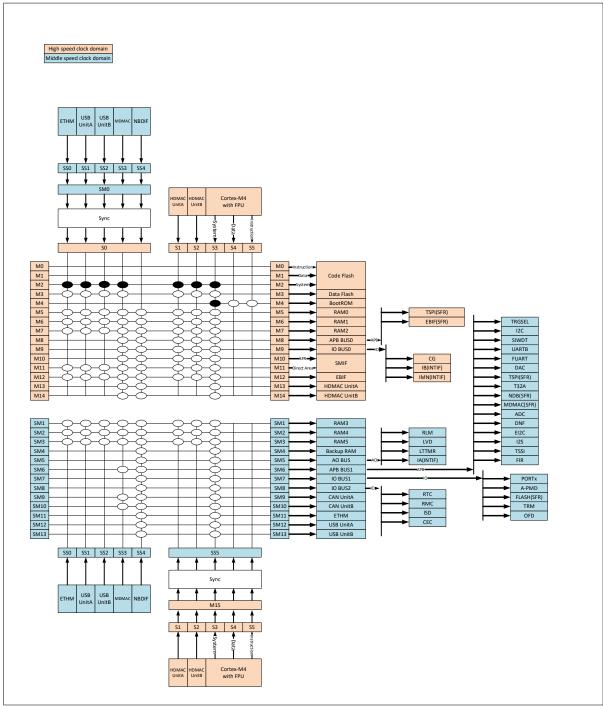
Note1: NBDIF is not connected to M2, M3.

Note2: Access between the high-speed domain and the middle-speed domain requires synchronization time between domains.

Figure 2.5 Single Chip Mode



2.2.1.2. Single Boot Mode



Note1: NBDIF is not connected to M2, M3.

Note2: Access between the high-speed domain and the middle-speed domain requires synchronization time between domains.

Figure 2.6 Single Boot Mode



2.2.2. Connection Table

2.2.2.1. Code Area/SRAM Area/SMIF Area/External Bus Area

- (1) TMPM4NxF20
 - Single chip mode

Table 2.1 TMPM4NxF20 Single Chip Mode

| Tubic 2.1 Tim material 20 only mode | | | | | | | | | | | | |
|-------------------------------------|--|-----|-----------|---------------|---------------|-----------------|----------|-----------------|-----------------|---------------|---------------|---------------|
| | | | | S | ub manag | er | | | Ma | ain manag | jer | |
| Start address | Subordina | ate | ЕТНМ | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S5 |
| 000000000 | Os da Flash | MO | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | ✓ |
| 0x00000000 | Code Flash | M1 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ✓ | Fault |
| 0x00200000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | - |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20020000 | RAM2 | M7 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20028000 | RAM3 | SM1 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x30000000 | Data Flash | М3 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| | | | For the a | ddress of tl | nis area, re | fer to "Tabl | e 2.9 Pe | ripheral Are | ea". | | | |
| 0x5E000000 | Code Flash (Mirror) | M2 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x5E200000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | = |
| 0x60000000 | External Bus Interface area (EBIF) | M12 | ✓ | ✓ | ✓ | √ | ✓ | √ | √ | √ | - | - |
| 0x80000000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | √ | √ | √ | ~ | √ | ~ | ~ | √ | - | - |

^{✓:} Accessible, - : No access, Fault: Fault occurred



• Single boot mode

Table 2.2 TMPM4NxF20 Single Boot Mode

| | | | | s | ub manag | er | | | M | ain manag | er | |
|---------------|--|-----|-----------|---------------|---------------|-----------------|-----------|-----------------|-----------------|---------------|---------------|---------------|
| Start address | Subordin | ate | ETHM | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S5 |
| 0x00000000 | Boot ROM | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ |
| 0x00008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | = | Fault | Fault |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20020000 | RAM2 | M7 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20028000 | RAM3 | SM1 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x30000000 | Data Flash | М3 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x3F7F8000 | Boot ROM (Mirror) | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ |
| 0x3F800000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| | | | For the a | ddress of th | nis area, re | fer to "Tabl | e 2.9 Per | ipheral Are | a". | | | |
| 0x5E000000 | Code Flash (Mirror) | M2 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x5E200000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | • |
| 0x60000000 | External Bus Interface area (EBIF) | M11 | ✓ | √ | √ | * | √ | ~ | ~ | √ | ı | - |
| 0x80000000 | Fault | ı | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | √ | √ | √ | √ | ✓ | ✓ | √ | ✓ | - | - |

^{✓:} Accessible, -: No access, Fault: Fault occurred



- (2) TMPM4NxF15
 - Single chip mode

Table 2.3 TMPM4NxF15 Single Chip Mode

| | | | | S | ub manag | er | | | M | ain manag | er | |
|---------------|---|-----|------------|--------------|--------------|--------------|----------|-------------|----------|-----------|----------|----------|
| Start address | Subordin | -4- | ЕТНМ | USB | USB | MDMAC | NBDIF | HDMAC | HDMAC | Core | Core | Core |
| Start address | Suborum | ale | EINN | Unit A | Unit B | Unit A | NDDIF | Unit A | Unit B | S-Bus | D-Bus | I-Bus |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S5 |
| 0x00000000 | Code Flash | МО | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | ✓ |
| 0x0000000 | (Area0) | M1 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ✓ | Fault |
| 0x00180000 | Reserved | ı | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |
| 0x00200000 | Fault | ı | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | - |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20020000 | RAM2 | M7 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20028000 | RAM3 | SM1 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x30000000 | Data Flash | МЗ | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| | | | For the ad | dress of thi | s area, refe | er to "Table | 2.9 Peri | pheral Area | a". | | | |
| 0x5E000000 | Code Flash (Mirror) | M2 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x5E180000 | Reserved | - | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |
| 0x5E200000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x60000000 | External Bus Interface area (EBIF) | M12 | √ | √ | √ | √ | √ | √ | √ | √ | - | - |
| 0x80000000 | Fault | ı | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | ~ | ~ | ~ | ~ | ~ | ~ | ~ | ~ | - | - |

^{✓:} Accessible, -: No access, Fault: Fault occurred



• Single boot mode

Table 2.4 TMPM4NxF15 Single Boot Mode

| | | | | Sub m | anager | | | | Main m | nanager | | |
|---------------|---|-----|------------|---------------|---------------|-----------------|-----------|-----------------|-----------------|---------------|---------------|---------------|
| Start address | Subordina | ate | ЕТНМ | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S5 |
| 0x00000000 | Boot ROM | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ |
| 0x00008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | Fault |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20020000 | RAM2 | M7 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20028000 | RAM3 | SM1 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x30000000 | Data Flash | МЗ | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault |
| 0x3F7F8000 | Boot ROM (Mirror) | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ |
| 0x3F800000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| | | F | or the add | ress of this | area, refe | r to "Table | 2.9 Perip | heral Area | ". | | | |
| 0x5E000000 | Code Flash (Mirror) | M2 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x5E180000 | Reserved | ı | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |
| 0x5E200000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x60000000 | External Bus Interface area (EBIF) | M11 | √ | √ | √ | √ | ✓ | √ | √ | √ | - | - |
| 0x80000000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |

^{✓:} Accessible, -: No access, Fault: Fault occurred



- (3) TMPM4NxF10
 - Single chip mode

Table 2.5 TMPM4NxF10 Single Chip Mode

| | | | | Sub manager | | | | | Main manager | | | | | |
|---------------|---|-----|------------|---------------|---------------|-----------------|----------|-----------------|-----------------|---------------|---------------|---------------|--|--|
| Start address | Subordina | ate | ETHM | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus | | |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S 5 | | |
| 000000000 | Code Floor | MO | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | ✓ | | |
| 0x00000000 | Code Flash | M1 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ✓ | Fault | | |
| 0x00100000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | - | | |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | | |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | | |
| 0x20020000 | RAM2 | M7 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | | |
| 0x20028000 | RAM3 | SM1 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | | |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | | |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | | |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - | | |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | | |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | | |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | | |
| 0x30000000 | Data Flash | МЗ | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - | | |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | | |
| | | F | or the add | ress of this | s area, ref | er to "Table | 2.9 Pe | ripheral Are | ea". | | | | | |
| 0x5E000000 | Code Flash (Area0) (Mirror) | M2 | ✓ | √ | √ | ✓ | Fault | ✓ | ✓ | ✓ | - | - | | |
| 0x5E100000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | | |
| 0x60000000 | External Bus Interface area (EBIF) | M12 | √ | √ | √ | ~ | √ | √ | √ | ✓ | - | - | | |
| 0x80000000 | Fault | ı | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | | |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | ✓ | ✓ | ✓ | √ | ✓ | ✓ | √ | ✓ | - | - | | |

^{✓:} Accessible, -: No access, Fault: Fault occurred



• Single boot mode

Table 2.6 TMPM4NxF10 Single Boot Mode

| | Subordinate | | | S | ub manag | er | | Main manager | | | | | |
|---------------|---|-----|-------------|---------------|---------------|-----------------|----------|-----------------|-----------------|---------------|---------------|---------------|--|
| Start address | | | ЕТНМ | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus | |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S5 | |
| 0x00000000 | Boot ROM | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ | |
| 0x00008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | Fault | |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | |
| 0x20010000 | RAM1 | М6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | | |
| 0x20020000 | RAM2 | M7 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | |
| 0x20028000 | RAM3 | SM1 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | | |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - | |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x30000000 | Data Flash | МЗ | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - | |
| 0x3F7F8000 | Boot ROM (Mirror) | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ | |
| 0x3F800000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| | | • | For the add | dress of thi | s area, ref | er to "Table | 2.9 Peri | pheral Area | a". | | | | |
| 0x5E000000 | Code Flash (Mirror) | M2 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - | |
| 0x5E100000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x60000000 | External Bus Interface area (EBIF) | M11 | √ | ✓ | √ | √ | √ | ✓ | √ | √ | - | 1 | |
| 0x80000000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ı | |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | ✓ | √ | ✓ | √ | ✓ | ✓ | ✓ | ✓ | - | - | |

^{✓:} Accessible, -: No access, Fault: Fault occurred



(4) TMPM4NxFD

• Single chip mode

Table 2.7 TMPM4NxFD Single Chip Mode

| | Subordinate | | | S | ub manag | er | | Main manager | | | | | |
|---------------|---|-----|------------|---------------|---------------|-----------------|----------|-----------------|-----------------|---------------|---------------|---------------|--|
| Start address | | | ETHM | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus | |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S 5 | |
| 0x00000000 | Code Flash | MO | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | ✓ | |
| | | M1 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ✓ | Fault | |
| 0x00080000 | Reserved | - | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | |
| 0x00100000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | - | |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | |
| 0x20020000 | Reserved | - | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - | |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - | |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x30000000 | Data Flash | М3 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - | |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| | | | For the ad | dress of thi | s area, refe | er to "Table | 2.9 Peri | pheral Area | a". | | • | | |
| 0x5E000000 | Code Flash (Mirror) | M2 | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - | |
| 0x5E080000 | Reserved | - | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | |
| 0x5E100000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0x60000000 | External Bus Interface area (EBIF) | M12 | √ | √ | ✓ | ✓ | √ | √ | √ | ✓ | - | - | |
| 0x80000000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - | |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | ✓ | √ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - | |

^{✓:} Accessible, -: No access, Fault: Fault occurred



• Single boot mode

Table 2.8 TMPM4NxFD Single Boot Mode

| | | | | S | ub manag | er | | Main manager | | | | |
|---------------|--|-----|------------|---------------|---------------|-----------------|------------|-----------------|-----------------|---------------|---------------|---------------|
| Start address | Subordinat | е | ЕТНМ | USB Unit A | USB Unit B | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S 5 |
| 0x00000000 | Boot ROM | M4 | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ |
| 0x00001800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | Fault | Fault |
| 0x20000000 | RAM0 | M5 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20010000 | RAM1 | M6 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x20020000 | Reserved | - | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |
| 0x20030000 | RAM4 | SM2 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20038000 | RAM5 | SM3 | ✓ | ✓ | ✓ | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040000 | Backup RAM | SM4 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x20040800 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x22000000 | Bit band alias | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x221C0000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x30000000 | Data Flash | МЗ | ✓ | ✓ | ✓ | ✓ | Fault | ✓ | ✓ | ✓ | - | - |
| 0x30008000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x3F7F8000 | Boot ROM (Mirror) | M4 | ✓ | ✓ | ✓ | Fault | Fault | Fault | Fault | ✓ | ✓ | ✓ |
| 0x3F800000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| | | | For the ad | dress of thi | is area, refe | er to "Table | e 2.9 Peri | pheral Are | a". | | | |
| 0x5E000000 | Code Flash (Area0) (Mirror) | M2 | √ | ✓ | ✓ | ✓ | Fault | ✓ | √ | √ | - | - |
| 0x5E080000 | Reserved | - | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |
| 0x5E100000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x60000000 | External Bus Interface area (EBIF) | M12 | √ | √ | √ | ✓ | ✓ | √ | √ | √ | - | - |
| 0x80000000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0xA0000000 | Serial memory interface area (SMIF) | M11 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | √ | - | - |

^{✓:} Accessible, -: No access, Fault: Fault occurred



2.2.2.2. Peripheral Area

Table 2.9 Peripheral Area

| | | | | S | ub manag | er | | Main manager | | | | |
|---------------|-------------------|------|-------|---------------|---------------|-----------------|----------|-----------------|-----------------|---------------|---------------|---------------|
| Start address | Subordina | ite | ЕТНМ | USB Unit A | USB Unit A | MDMAC Unit A | NBDIF | HDMAC Unit A | HDMAC Unit B | Core S-Bus | Core D-Bus | Core I-Bus |
| | | | SS0 | SS1 | SS2 | SS3 | SS4 | S1 | S2 | S3 | S4 | S5 |
| 0x40000000 | HDMAC (Unit A) | M13 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | ı |
| 0x40001000 | HDMAC (Unit B) | M14 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x40002000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ı |
| 0x40005000 | CAN (Unit A) | SM9 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | √ | - | 1 |
| 0x40006000 | CAN (Unit B) | SM10 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x40007000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x4000A000 | ETHM | SM11 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x4000C000 | SMIF (SFR) | M10 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x4000D000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x4003E000 | IA (INTIF) | SM5 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x4003E400 | RLM | SM5 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x4003EC00 | LVD | SM5 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x4003FF00 | LTTMR | SM5 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x4006A000 | TSPI (ch0 to 5) | M8 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x40076000 | EBIF (SFR) | M8 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x40083000 | CG | M9 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x40083200 | IB (INTIF) | M9 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x40083300 | IMN | M9 | Fault | Fault | Fault | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| 0x400A0200 | DNF (ch0, 1) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400A0400 | TRGSEL | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400A0600 | SIWDT | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | 1 |
| 0x400A2000 | NBDIF | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400A4000 | MDMAC | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400A8000 | FUART (ch0, 1) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400BA000 | ADC | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400BC800 | DAC (ch0, 1) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | 1 |
| 0x400C1000 | T32A (ch0 to 15) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | ı |
| 0x400CB800 | TSPI (ch6 to 8) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400CD000 | TSSI (ch0, 1) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | 1 |
| 0x400CE000 | UART (ch0 to 5) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | |
| 0x400D0000 | I2S (ch0, 1) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400D1000 | I2C (ch0 to 4) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400D8000 | EI2C (ch0 to 4) | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400DD000 | FIR | SM6 | Fault | Fault | Fault | ✓ | ✓ | Fault | Fault | ✓ | - | - |
| 0x400E0000 | PORT | SM7 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x400E3100 | TRM | SM7 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x400E4000 | OFD | SM7 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x400E4800 | RTC | SM8 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x400E8000 | CEC | SM8 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x400E8100 | RMC (ch0, 1) | SM8 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | ı |
| 0x400E9000 | A-PMD | SM7 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x400F0000 | ISD | SM8 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x40100000 | USB (Unit A) | SM12 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | ı |
| 0x40140000 | USB (Unit B) | SM13 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |
| 0x40180000 | Fault | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | ı |
| 0x42000000 | Bit Band Alias | - | Fault | Fault | Fault | Fault | Fault | Fault | Fault | ✓ | - | - |
| 0x44000000 | Fault | _ | Fault | Fault | Fault | Fault | Fault | Fault | Fault | Fault | - | - |
| 0x5DFF0000 | Flash (SFR) | SM7 | Fault | Fault | Fault | Fault | ✓ | Fault | Fault | ✓ | - | - |

^{✓:} Accessible, - : No access, Fault: Fault occurred



2.2.3. RAM Access

The number of clocks required to access the internal RAM is shown in the table below.

Table 2.10 Number of Clocks to Access Each RAM

| RAM | fsys | No. of clocks | Description |
|------------|------------|---------------|--|
| RAM0 | fsysh | 1 | - |
| RAM1 | fsysh | 1 or 2 | Defer to "2.2.4.Liet of Degisters" |
| RAM2 | fsysh | 1 or 2 | Refer to "2.2.3.1 List of Registers". |
| RAM3 | fsysm 1 | | |
| RAM4 | fsysm | 1 | Access between the high-speed domain and |
| RAM5 | RAM5 fsysm | | the middle-speed domain requires synchronization time between domains. |
| Backup RAM | fsysm | 5 | |

2.2.3.1. List of Registers

Change the setting according to the fsysh frequency.

The register and address of FC are shown below.

| Derinheral function | Channaliunit | Base address | |
|---------------------|--------------|--------------|------------|
| Peripheral function | Channel/unit | TYPE1 | |
| Flash memory | FC | - | 0x5DFF0000 |

| Register name | | Address (Base+) |
|--------------------------------|-----------|-----------------|
| Flash Key Code Register (Note) | [FCKCR] | 0x0018 |
| RAM Access Control Register | [FCRACCR] | 0x1218 |

Note: These registers are same as registers of the reference manual "Flash memory".



2.2.3.2. Details of Register

(1) [FCKCR] (Flash Key Code Register)

| Bit | Bit symbol | After reset | Туре | Function |
|------|------------|-------------|------|--|
| 31:0 | KEYCODE | 0x00000000 | W | Locked register release key code When <i>[FCRACCR]</i> is rewritten, write the specific code (0xA74A9D23) to this register. And then rewrite the value of the register within 16 clocks after the previous action. If valid data is written to this register within 16 clocks, released status is reset. |

(2) [FCRACCR] (RAM Access Control Register)

| Bit | Bit symbol | After reset | Туре | Function |
|-------|-------------|-------------|------|---|
| 31:14 | - | 0 | R | Read as "0". |
| 13:12 | - | 00 | R/W | Write as "00". |
| 11:10 | - | 0 | R | Read as "0". |
| 9:8 | - | 00 | R/W | Write as "00". |
| 7:6 | - | 0 | R | Read as "0". |
| 5:4 | RAMLC1[1:0] | 00 | R/W | Access control to RAM1,RAM2 00: 1clock (fsysh ≤ 160MHz) 01: 2clocks (fsysh > 160MHz) Others: Reserved |
| 3:2 | - | 0 | R | Read as "0". |
| 1:0 | - | 00 | R/W | Write as "00". |

Note1: Rewrite the contents of this register on the program code in the Flash memory.

Note2: To rewrite this register, follow the procedure below:

- (a) Write the specific code (0xA74A9D23) to [FCKCR].
- (b) Rewrite data of [FCRACCR]<RAMLC1[1:0]> within 16 clocks after Procedure 1.
- (c) After wrote, check read data is same as wrote data.

Note3: When using clock gear, set this register according to the maximum frequency in the application. Do not change the setting even if the frequency is lowered with the clock gear.



3. Reset and Power Control

3.1. Outlines

This section describes how to turn on a power supply, and how to assert and deassert a power-on reset and reset.

| Function classification | Factor | Functional description |
|--|----------------|---|
| | Power-on reset | Reset which occurs at the time of turning on or off a power supply. |
| Cold reset | LVD reset | Reset which occurs when a power supply voltage is the set-up voltage or below. |
| (Reset by turning on a power supply) | Reset pin | Reset by a RESET_N pin |
| | PORF reset | Reset which occurs at the time of power supply turning on or turning off. Reset the Flash memory and debugging circuit with priority. |
| Warm reset (Reset without turning on a power | Internal reset | Reset by SIWDT, OFD, LVD, LOCKUP, and <sysresetreq></sysresetreq> |
| supply) | Reset pin | Reset by a RESET_N pin |
| | Interrupt | Reset which is performed to main power domain during return operation from the STOP2 mode. (STOP2REQ) |
| Reset by STOP2 mode release | LVD reset | Reset when DVDD3 is equal or less than the voltage which is set on LVD circuit. |
| | Reset pin | Reset by a RESET_N pin |
| Single boot mode start up | - | TMPM4N Group (1) start by boot ROM after releasing reset. |



3.2. Function and Operation

This section explains about power on, power off and reset.

Note: Refer to "Electrical Characteristics" of a datasheet for the time and voltage of description of the symbol in a figure.

3.2.1. Cold Reset

When turn on a power supply, the stabilization time for the built-in regulator, the built-in Flash memory, and the built-in high-speed oscillator is necessary. The TXZ+ family automatically inserts a wait time for the stabilization of these circuits.

When turning on the power, please make sure that the slope of the power supply voltage rises to the right.

When the power supply voltage drops and rises near POR and PORF detection, it may not operate normally even if the power supply voltage rises to the guaranteed operating range.



3.2.1.1. Reset by Power-on Reset Circuit (without Using RESET_N pin)

After a supply voltage exceeds the release voltage of a Power On Reset (POR), internal reset is deasserted after "Internal initialization time" is elapsed. Please increase a supply voltage goes up into an operating voltage range before "Internal initialization time" is elapsed. The CPU operates after internal reset is released.

After a supply voltage exceeds the release voltage of a Power On Reset (POR), LVD continues to output reset signal until supply voltage exceeds the LVD release voltage. And internal reset has priority during the time of "Internal initialization time". When rising time of a supply voltage beyond "Internal initialization time", please refer to "3.2.1.3. Continuation of Reset by LVD".

For example, if the operating voltage of a circuit board is more than 2.7V, after Power On Reset released, increase a supply voltage to 2.7V before "Internal initialization time" is elapsed.

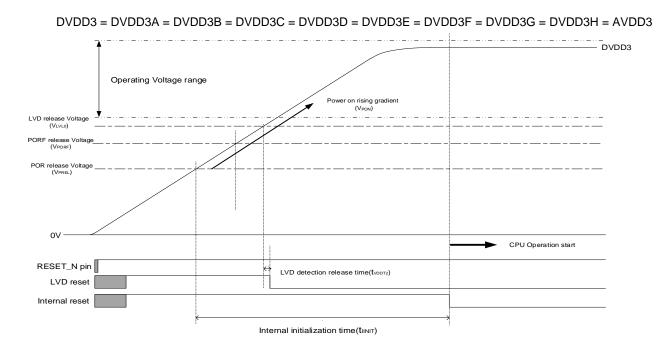


Figure 3.1 Reset Operation by Power-on Reset Circuit

Note: When you use only a Power On Reset Circuit without RESET_N pin, the RESET_N pin should input "High" level or opened.



3.2.1.2. Reset by RESET_N Pin

When turn on a power supply, it can control the timing of reset release by using RESET_N pin.

After a supply voltage exceeds the release voltage of a power-on reset and even after "Internal initialization time" elapsed, if the RESET_N pin is "Low", internal reset continues.

After a supply voltage goes up into an operating voltage range, if a RESET_N pin becomes "High" level, internal reset is deasserted after "CPU waiting time" elapses.

DVDD3 = DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H = AVDD3

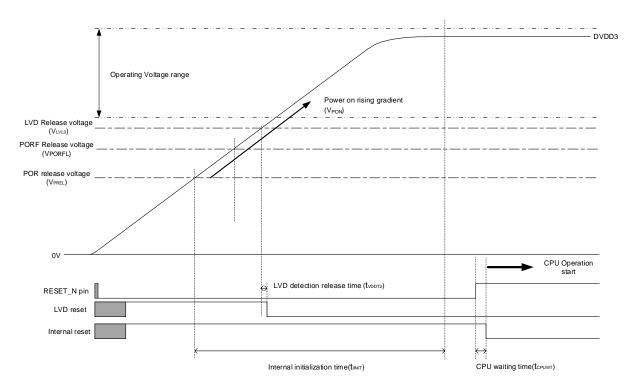


Figure 3.2 Reset Operation by RESET_N Pin (1)



In case of RESET_N pin input change from "Low" level to "High" level before "Internal initialization time" elapses, internal reset signal is released after "Internal initialization time" elapses.

Please goes up a supply voltage into an operating voltage range before "Internal initialization time" elapses. The CPU operates after internal reset release.

DVDD3 = DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H = AVDD3

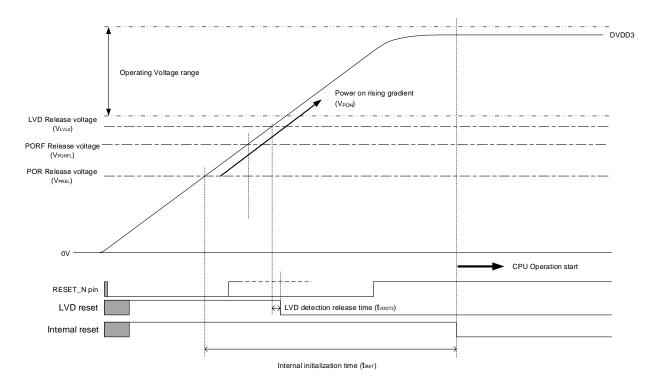


Figure 3.3 Reset Operation by RESET_N Pin (2)



3.2.1.3. Continuation of Reset by LVD

When the power supply voltage has not exceeded the LVD release voltage even after "Internal initialization time" elapsed, LVD generates the reset signal and the reset state continues. After the power supply voltage exceeds the LVD release voltage and "LVD detection release time" + "CPU operation wait time" elapses, the internal reset is deasserted. And CPU starts operating. Refer to reference manual "Voltage detection circuit" for detail of LVD.

DVDD3 = DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H = AVDD3

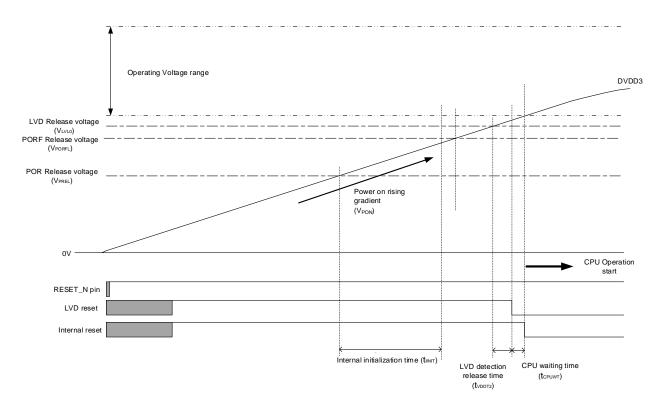


Figure 3.4 Reset Operation by LVD Reset



3.2.2. Warm Reset

3.2.2.1. Warm Reset by REST_N Pin

When resetting with the RESET_N pin, set the RESET_N pin to "Low" level for 17.2 µs or more while the power supply voltage is within the operating range.

When the "Low" level period of a RESET_N pin is longer than "Internal processing time", after a RESET_N pin changes to "High" level, internal reset is released after "CPU waiting time" elapsed.

When the "Low" level period of a RESET_N pin is shorter than "Internal processing time", after internal reset is extended and from a RESET_N pin changes "Low" level, internal reset is release after "Internal processing time" + "CPU waiting time" has elapsed, internal reset will be released.

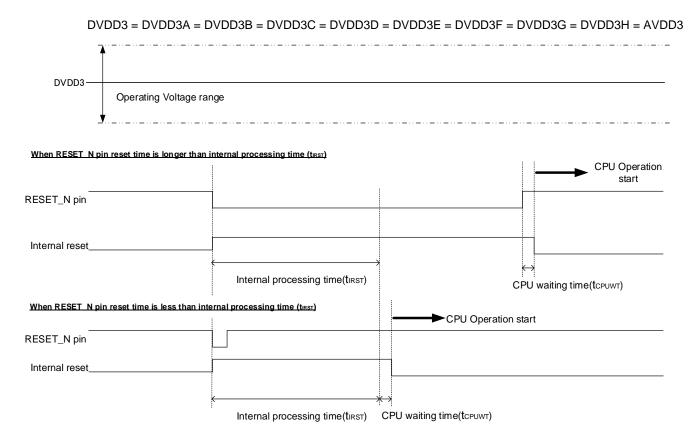


Figure 3.5 Warm Reset Operation

3.2.2.2. Warm Reset by Internal Reset

In case of reset asserted by internal factors, such as SIWDT, OFD, LVD, LOCKUP, and <SYSRESETREQ>, internal reset is released after "Internal processing time" + "CPU waiting time" elapsed.



3.2.3. Reset by STOP2 Mode Release

When RESET_N pin changed "Low" level or LVD reset occurred during STOP2 mode, STOP2 released. The power supply is turned on and assert reset to main power domain. After RESET_N pin changes to "High" level or LVD reset released, start operation in NORMAL mode. At that time, condition of CPU is as same as cold reset except [RLMLOSCCR], [RLMRSTFLG0], [RLMRSTFLG1].

When asserted interrupt request during STOP2 mode, also STOP2 released. The power supply is turned on and assert reset to main power domain in the sequence of releasing STOP2 mode. Refer to "1.3.3.3. Restart Operation from STOP2 Mode" for the operation at the time of STOP2 release.



3.2.4. Starting Single Boot Mode

For the details of the single mode, refer to reference manual "Flash memory".

3.2.4.1. Starting Single Boot Mode by RESET_N Pin

When "Low" level is input to a Boot_N pin, and then reset release, "single Boot mode" will be started.

When turn on power supply, the time of input "Low" level to the RESET_N pin is equal to or longer than "Internal initialization time" to reset. And deassert RESET_N pin to "High", after a supply voltage goes up into an operating voltage range.

DVDD3 = DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H = AVDD3

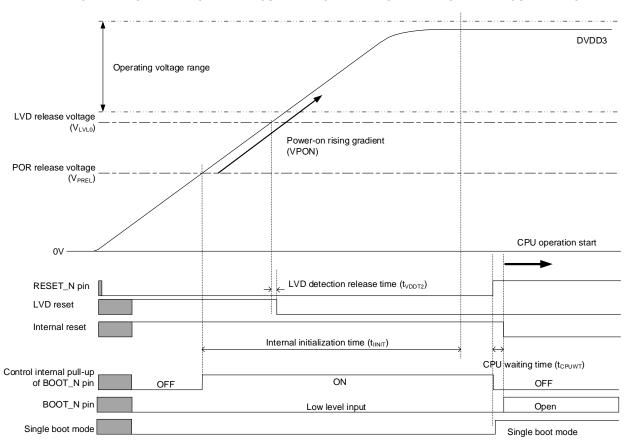


Figure 3.6 Starting Single Boot Mode by RESET_N Pin



3.2.4.2. Starting Single Boot Mode by Power-on Reset (Not Using RESET_N Pin)

When and turning on power supply, "Low" level is input to Boot_N pin. After the internal reset is deasserted, the CPU operation starts, and the single boot mode starts up.

DVDD3 = DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H = AVDD3 Operating Voltage Rage LVD Release (VLVLO) Power on rising gradient (V_{PON}) POR Release Voltage (VPREL) **CPU** Operation RESET_N pin └─ LVD detection release time(tvddt2) LVD reset Internal reset Internal initialization time(tinnit) Control internal Pull-up of BOOT_N pin OFF BOOT_N pin ow level input Open Single boot Single boot mode

Figure 3.7 Starting Single Boot Mode by Power-on Reset (Not Using RESET_N Pin)



3.2.4.3. Starting Single Boot Mode when Power Supply is Stable

When the supply voltage is stable within an operating voltage range, input "Low" level to RESET_N pin for reset equal to or longer than "Internal processing time", while "Low" level is input to the Boot_N pin.

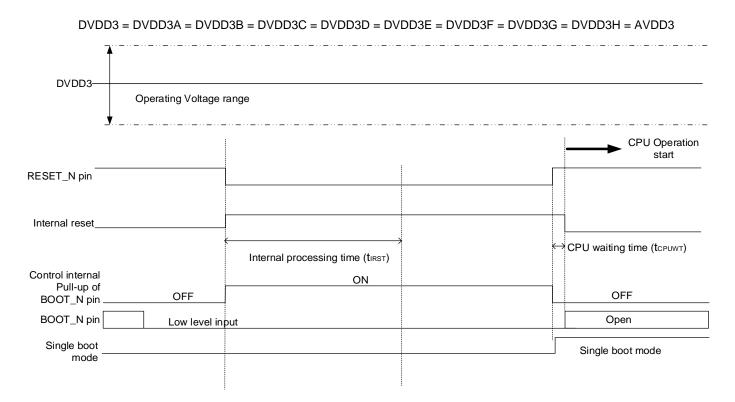


Figure 3.8 Starting Single Boot Mode when Power Supply is Stable



3.2.5. Power-on Reset Circuit

The power-on reset circuit (POR) generates a reset signal when the power is turned on or turned off.

Note: The power-on reset circuit may not operate correctly due to the fluctuation of the power supply. Equipment should be designed with full consideration of the electrical characteristics.

The power-on reset circuit consists of a detection voltage generation circuit, a reference voltage generation circuit, and a comparator.

The supply voltage has referred to DVDD3 (= DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H).

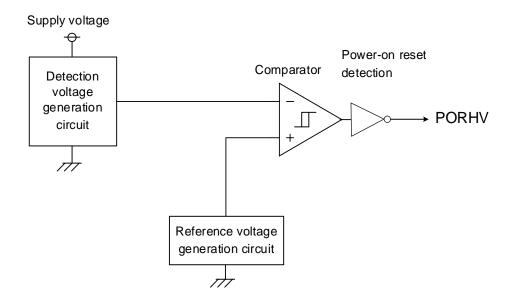


Figure 3.9 Power-on Reset Circuit

3.2.5.1. Operation at Time of Turn On

When turn on power supply, while the power supply voltage is equal to or lower than power-on reset release voltage (VPREL), the power-on reset detection signal is generated. Refer to "Figure 3.1 Reset Operation by Power-on Reset Circuit" for detail.

While the power-on reset signal is generated, the reset is asserted to the CPU and the peripherals.

3.2.5.2. Operation at Time of Turn Off

When turn off power supply, while the power supply voltage is equal to or lower than power-on reset detection voltage (V_{PDET}), the power-on Reset detection signal is generated.

While the power-on Reset signal is generated, the reset is asserted to the CPU and the peripherals.



3.2.6. Precautions when Turning Off Power

When turning off the power, always follow the prescribed procedure to reduce the power supply voltage.

DVDD3 = DVDD3A = DVDD3B = DVDD3C = DVDD3D = DVDD3E = DVDD3F = DVDD3G = DVDD3H = AVDD3

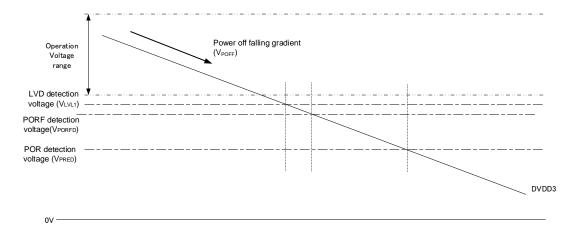


Figure 3.10 Falling Gradient when Turning Off Power

Flash memory and circuits that include debug are reset by PORF reset. Refer to "3.2.8.1. Reset Factor and Reset Range" for detail.



3.2.7. About Turn On Power Supply after Turn Off

3.2.7.1. When Using External Reset Circuit or Internal LVD Reset Output

When the power supply is turned off and the power supply voltage drops below the operation guaranteed voltage, reset is performed with an external reset circuit or built-in LVD (when the voltage is less than the set voltage). After that, from the state where the reset is applied, please follow the same constraints as when turning on the power and turned on the power supply voltage.

3.2.7.2. When not Using External Reset Circuit and Internal LVD Reset Output

When the power supply is turned off and the power supply voltage drops below the operation guaranteed voltage, be sure to lower the power supply voltage below the power-on reset detection voltage (V_{PDET}) and hold it for 200 μ s or more. After that, please follow the same constraints as when turning on the power and turned on the power supply voltage.

When the power supply voltage drops below the power-on reset detection voltage (V_{PDET}) and cannot be held for 200 μ s or more, or when the same constraints as at Power on cannot keep, the CPU may not operate properly.

3.2.7.3. When Boundary Scan is Used

When the power supply is turned off and the power supply voltage drops below the operation guaranteed voltage, a voltage of power supply must go to 0V. Follow the same constraints as when turning on the power and turned on the power supply voltage.

3.2.8. After Reset Release

All of the control register of Cortex-M4 (with FPU) core and the peripheral function control register (SFR) are initialized by reset. But depend on the reset factor, initialized range is different.

Please refer to "Table 3.1 Reset Factor and Range Initialized" for the initialized range by each reset factor.

The reset factor when reset occurs can be checked by a reset flag register which are [RLMRSTFLG0] and [RLMRSTFLG1]. For detail of [RLMRSTFLG0] and [RLMRSTFLG1], please refer to reference manual "Exception".

After the reset is released, CPU starts operation by a clock of internal high-speed oscillator 1 (IHOSC1). The external clock and PLL multiple circuit should be set if necessary.



3.2.8.1. Reset Factor and Reset Range

Reset factors and the range initialized are shown in Table 3.1.

Table 3.1 Reset Factor and Range Initialized

| | | | Jie 3.1 K | | tor arra re | ange initi | u | | | | |
|---|---|---------------------|------------------------------------|----------------|--------------|--------------------|----------------|---------------|---|------------------------|--|
| | | | | | R | eset factor | rs | | | | |
| Registers and peripheral function | | STOP2 mode release | | Cold reset | | Warm reset (Note1) | | | | | |
| | | Interrupt factor | Reset pin (Note1) (Note3) | POR (Note1) | Reset pin | OFD reset | SIWDT reset | LVD reset | CPU <sys RESET REQ> reset</sys | CPU LOCKUP reset | |
| | Reset signal name | STOP2 REQ | RESET_N | PORHV | RESET_N | OFD RSTOUT | WDT RSTOUT | LVD RSTOUT | SYS RESET REQ | LOCKUP RESET REQ | |
| RTC | [RTCSECR] [RTCMINR] [RTCHOURR] [RTCDAYR] [RTCDATER] [RTCMONTHR] [RTCYEARR] [RTCADJCTL] [RTCADJDAT] [RTCADJSIGN] [RTCPAGER] (Note2) Except above | - | - | - | - | - | - | - | - | - | |
| Low-speed | [RLMSHTDNOP] | , | √ | → | · · | → | → | → | → | ✓ | |
| oscillation/ power control Reset flag | [RLMPROTECT] [RLMLOSCCR] [RLMRSTFLG0] [RLMRSTFLG1] | - | - | √ | - | - | - | - | - | - | |
| Interrupt | [IAIMCxx] [IANIC00] | - | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | |
| control | [IBIMCxxx] [IBNIC00] | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | |
| Flash | [FCSBMR] | ✓ | ✓ | ✓ | - (Note4) | - | - | - (Note4) | - | - | |
| Port | All registers | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | |
| C | OFD | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | |
| L | _VD | - | ✓ | ✓ | ✓ | - | - | - | - | - | |
| LTTMR, IS | D, RMC, CEC | - | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | |
| Debuggi | ng interface | ✓ | ✓ | ✓ | - (Note4) | - | - | - (Note4) | - | - | |
| Excep | ot above | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | |

✓ : It is initialized.

- : It is not initialized.

Note1: When reset is performed, the data of built-in RAM will not be guaranteed.

Note2: [RTCPAGER]<ENATMR><ENAALM> are not initialized. Other symbols are initialized.

Note3: Reset area released by LVD reset in STOP2 mode is reset area released by the warm-reset.

Note4: Debug interface is initialized by the reset in STOP1mode. And it is not initialized by the reset in NORMAL, IDLE, or STOP mode.



4. Revision History

Table 4.1 Revision History

| Dovinion | Doto | Description |
|----------|------------|--|
| Revision | Date | Description |
| 1.0 | 2020-12-22 | - First release |
| 1.1 | 2023-06-14 | - Table 1.10 Block operation status in each Low-power consumption mode The operation status of SIWDT in STOP1 mode is changed. "IDLE mode" in note 2 is changed to "IDLE/STOP1 mode". - 1.3.2.1. IDLE mode transition flow Note is added. - 1.3.2.3. STOP2 mode transition flow Note is deleted. - Correct Figure 1.3. - 1.3.3.3. The restart operation from the STOP2 mode Change Note2 to Note3, and Note3 is corrected. Added Note2. - 1.3.4.2. NORMAL → ISTOP1 → INORMAL Operation mode transition Added Note. - 1.3.4.3. NORMAL → STOP2 → RESET → NORMAL Operation mode transition Added Note. - 3.1 Outline Table Added LVD reset factor. - 3.2.3. Reset by STOP2 mode release Changed description. - Table 3.1 A reset factor and the initialized range Deleted "PORF" from interrupt factor in table 3.1. Added Note3 in STOP2 Release, Reset pin column. Added Note4 to Flash [FCSBMR] in Warm reset, Reset pin and LVD reset. Added Note4 to debug interface in Warm reset, Reset pin and LVD reset. Added Note3 and Note4. |
| 1.2 | 2023-09-15 | - Figure 1.1 Clock system diagram Figure 1.1 is changed. - 1.3.1.4. The peripheral function state in a Low-power consumption mode Note2 is changed. |
| 1.3 | 2024-05-31 | - 1.2.3. Clock System diagram Figure. 1.1. Clock System Diagram is changed 1.2.6.1 Setting Method of System Clock (1) fosc setup (internal oscillation → external oscillation) Table "< <state before="" switching="">>" is changed. Note is added. (2) fosc setup (internal oscillation → external clock input) Step 1 in the table "<<example of="" procedure="" switching="">>" is changed. (3) fosc setup (external oscillation/external clock input → internal oscillation) Step 5 in the table "<< Example of switching procedure >>" is changed 1.2.7. Low-speed Clock (1) ELOSC setup (not used low-speed clock → external low-speed oscillator used) <<example of="" procedure="" switching="">> is changed. (2) ELCLKIN setup (No Operation of External Low-speed Oscillator → Operation) <<example of="" procedure="" switching="">> is changed 1.4.2.13. [CGSPCLKEN] (Clock Supply for ADC and Debug Circuit Register) Note1 and note2 are added 1.4.2.15. [RLMLOSCCR] (Low-speed Oscillation and Internal High-speed Oscillation 2 Clock Control Register) The function of <xten> is changed 2.2 Bus Matrix A description is changed 3.2.7. About Turn On Power Supply after Turn Off "3.2.7.3. When Boundary Scan is Used" is added 3.2.8.1. Reset Factor and Reset Range Table 3.1 Reset Factor and Range Initialized It is changed that registers and circuit of LVD are initialized by RESET_N pin at warm reset.</xten></example></example></example></state> |



| Revision | Date | Description |
|----------|------------|--|
| 1.4 | 2025-07-11 | - 1.3.2.3. STOP2 Mode Transition Flow Changed table |



RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY
 HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF
 HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for
 specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities,
 equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships
 and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and
 escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR
 PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any
 infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any
 intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR
 PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER,
 INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING
 WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2)
 DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR
 INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE,
 ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please
 use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without
 limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF
 NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

Toshiba Electronic Devices & Storage Corporation

https://toshiba.semicon-storage.com/